

# HT46R51/HT46R52 A/D Type 8-Bit OTP MCU

# **Technical Document**

- Tools Information
- FAQs
- Application Note
  - HA0003E Communicating between the HT48 & HT46 Series MCUs and the HT93LC46 EEPROM
  - HA0004E HT48 & HT46 MCU UART Software Implementation Method
  - HA0084E NiMH Battery Charger Demo Board Using the HT46R52

### Features

- Low-power fully static CMOS design
- Operating voltage: f<sub>SYS</sub>=4MHz: 2.2V~5.5V f<sub>SYS</sub>=8MHz: 3.3V~5.5V
- Program Memory: 1K×14 OTP (HT46R51) 2K×14 OTP (HT46R52)
- Data memory: 88×8 RAM
- A/D converter: 12bits×5Ch External A/D converter reference voltage input pin
- 14 bidirectional I/O lines
- 1 interrupt input shared with an I/O line
- 8-bit programmable timer/event counter with overflow interrupt and 7-stage prescaler

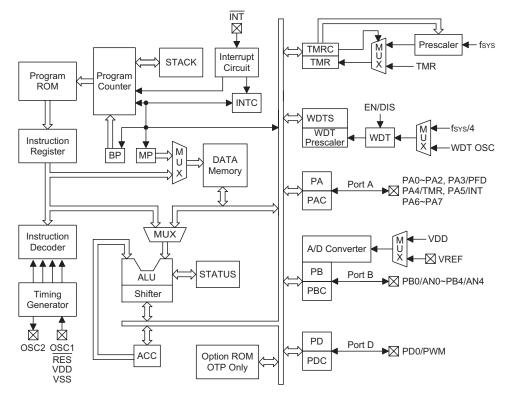
- On-chip crystal and RC oscillator
- 6-level subroutine nesting
- Watchdog Timer
- Low voltage reset function
- HALT function
- Up to  $0.5 \mu s$  instruction cycle with 8MHz system clock at  $V_{DD}{=}5V$
- 1-channel 8-bit PWM output shared with an I/O line
- PFD function
- Bit manipulation instruction
- Table read instruction
- 63 powerful instructions
- · All instructions in one or two machine cycles
- 18-pin DIP, 20-pin SOP/SSOP package

## **General Description**

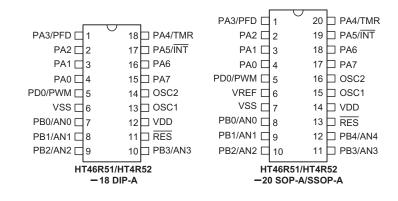
The HT46R51/HT46R52 are 8-bit high performance, RISC architecture microcontroller devices specifically designed for A/D applications that interface directly to analog signals, such as those from sensors. The advantages of low power consumption, I/O flexibility, timer functions, oscillator options, multi-channel A/D converter, Pulse Width Modulation function, HALT and wake-up functions, watchdog timer, as well as low cost, enhance the versatility of these devices to suit a wide range of A/D application possibilities such as sensor signal processing, chargers, motor driving, industrial control, consumer products, subsystem controllers, etc.



# **Block Diagram**



# **Pin Assignment**





# **Pin Description**

Pin Name	I/O	Options	Description
PA0~PA2 PA3/PFD PA4/TMR PA5/INT PA6~PA7	I/O	Pull-high Wake-up PA3 or PFD	Bidirectional 8-bit input/output port. Each individual bit on this port can be config- ured as a wake-up input by configuration option. Software instructions determine if the pin is a CMOS output or Schmitt trigger input. Configuration options deter- mine which pins on this port have pull-high resistors. The PFD, TMR and external interrupt input are pin-shared with PA3, PA4, and PA5 respectively.
PB0/AN0 PB1/AN1 PB2/AN2 PB3/AN3 PB4/AN4	I/O	Pull-high	Bidirectional 5-bit input/output port. Software instructions determine the CMOS output or Schmitt trigger input with or without pull-high resistor. Configuration options determine which pins on this port have pull-high resistors. PB is pin-shared with the A/D input pins. The A/D inputs are selected via software instructions Once selected as an A/D input, the I/O function and pull-high resistor functions are disabled automatically.
PD0/PWM	I/O	Pull-high PD0 or PWM	Bidirectional 1-bit input/output port. Software instructions determine the CMOS output or Schmitt trigger input with or without pull-high resistor. One configuration option determines which pin on this port has pull-high resistor. PD0 is pin-shared with the PWM output selected via configuration option.
OSC1 OSC2	I O	Crystal or RC	OSC1, OSC2 are connected to an external RC network or external crystal (deter- mined by configuration option) for the internal system clock. For external RC sys- tem clock operation, OSC2 is an output pin for 1/4 system clock.
RES	I		Schmitt trigger reset input, active low
VDD			Positive power supply
VSS			Negative power supply, ground
VREF	I		A/D Converter Reference Input voltage pins. Connect this pin to the desired A/D reference voltage. The VREF pin is connected to $V_{\rm DD}$ for the 18-pin DIP package

# Absolute Maximum Ratings

Supply VoltageV_SS=0.3V to V_SS+6.0V	Storage Temperature50°C to 125°C
Input VoltageV_SS=0.3V to V_DD+0.3V	Operating Temperature40°C to 85°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

# **D.C. Characteristics**

Ta=25°C

Symbol	Parameter		Test Conditions	Min.	<b>T</b>	Mex	11	
Symbol	Parameter	$V_{DD}$	Conditions	IVIIN.	Тур.	Max.	Unit	
V			f <sub>SYS</sub> =4MHz	2.2	_	5.5	V	
V <sub>DD</sub>	Operating Voltage	_	f <sub>SYS</sub> =8MHz	3.3	_	5.5	V	
1	Operating Current (Crystal OSC)		No load, f <sub>SYS</sub> =4MHz	_	0.6	1.5	mA	
I <sub>DD1</sub>			ADC disabled	_	2	4	mA	
1		3V	No load, f <sub>SYS</sub> =4MHz	_	0.8	1.5	mA	
I <sub>DD2</sub>	Operating Current (RC OSC)	5V	ADC disabled	_	2.5	4	mA	
I <sub>DD3</sub>	Operating Current		No load, f <sub>SYS</sub> =8MHz ADC disabled	_	4	8	mA	
	Standby Current (MDT Enchlad)	3V	No lood avatam LIALT	_	_	5	μA	
I <sub>STB1</sub>	Standby Current (WDT Enabled)		No load, system HALT	_	_	10	μA	



Cumhal	Dementer		Test Conditions		Тур.	Max.	11
Symbol	Parameter	V <sub>DD</sub>	Conditions	Min.			Unit
I	Standby Current	3V		_		1	μA
I <sub>STB2</sub>	(WDT & AD Disabled)	5V	No load, system HALT	_	_	2	μA
V <sub>IL1</sub>	Input Low Voltage for I/O Ports, TMR and INT	_	_	0	_	0.3V <sub>DD</sub>	V
V <sub>IH1</sub>	Input High Voltage for I/O Ports, TMR and INT	_		0.7V <sub>DD</sub>	_	V <sub>DD</sub>	V
V <sub>IL2</sub>	Input Low Voltage (RES)	_	_	0	_	$0.4V_{DD}$	V
V <sub>IH2</sub>	Input High Voltage (RES)	_	_	0.9V <sub>DD</sub>		V <sub>DD</sub>	V
V <sub>LVR</sub>	Low Voltage Reset Voltage	_	Configuration option: 3V	2.7	3	3.3	V
1		3V	× −0.1×	4	8		mA
I <sub>OL</sub>	I/O Port Sink Current	5V	V <sub>OL</sub> =0.1V <sub>DD</sub>	10	20	_	mA
1	1/O Dart Courses Current	3V	3V V <sub>OH</sub> =0.9V <sub>DD</sub>	-2	-4		mA
I <sub>ОН</sub>	I/O Port Source Current	5V	VOH-0.9VDD	-5	-10		mA
D	Dull high Desistance of UO Darts	3V		20	60	100	kΩ
R <sub>PH</sub>	Pull-high Resistance of I/O Ports	5V		10	30	50	kΩ
V <sub>AD</sub>	A/D Input Voltage	_	_	0	_	V <sub>REF</sub>	V
V <sub>REF</sub>	ADC Input Reference Voltage Range	_	_	1.2	_	VDD	V
DNL	ADC Differential Non-Linear	_	_	_		±2	LSB
INL	ADC Integral Non-Linear	_			±2.5	±4	LSB
RESOLU	Resolution	_	_	_		12	Bits
1	Additional Power Consumption	3V		_	0.5	1	mA
I <sub>ADC</sub>	if A/D Converter is Used		] —	_	1.5	3	mA

# A.C. Characteristics

### Ta=25°C

Symbol	Demension		Test Conditions		-		11	
Symbol	Parameter	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit	
£	Questere Clask (Crustel OCO)	_	2.2V~5.5V	400	_	4000	kHz	
f <sub>SYS</sub>	System Clock (Crystal OSC)		3.3V~5.5V	400	_	8000	kHz	
		_	2.2V~5.5V	0	_	4000	kHz	
f <sub>TIMER</sub>	Timer I/P Frequency (TMR)		3.3V~5.5V	0	_	8000	kHz	
twdtosc		3V		45	90	180	μs	
	Watchdog Oscillator Period	5V		32	65	130	μs	
t <sub>RES</sub>	External Reset Low Pulse Width	_		1			μs	
t <sub>SST</sub>	System Start-up Timer Period	_	Wake-up from HALT		1024		t <sub>SYS</sub>	
t <sub>INT</sub>	Interrupt Pulse Width			1	_	_	μs	
t <sub>AD</sub>	A/D Clock Period			1			μs	
t <sub>ADC</sub>	A/D Conversion Time	_		_	80	_	t <sub>AD</sub>	
t <sub>ADCS</sub>	A/D Sampling Time	_	_	_	32	_	t <sub>AD</sub>	

Note: t<sub>SYS</sub>=1/f<sub>SYS</sub>



## **Functional Description**

#### **Execution Flow**

The system clock for the microcontroller is derived from either a crystal or an RC oscillator. The system clock is internally divided into four non-overlapping clocks. One instruction cycle consists of 4 system clock cycles.

Instruction fetching and execution are pipelined in such a way that a fetch and decoding takes an instruction cycle while execution take the next instruction cycle. The pipelining scheme causes each instruction to effectively execute in a cycle. If an instruction changes the program counter, two cycles are required to complete the instruction.

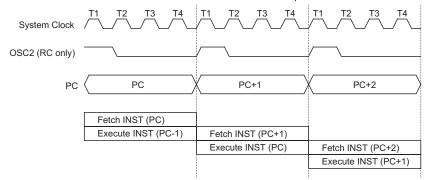
#### **Program Counter – PC**

For HT46R51, the program counter (PC) is 10 bits wide and controls the sequence in which the instructions stored in the program ROM are executed. The contents of the PC can specify a maximum of 1024 addresses. For HT46R52, the program counter (PC) is 11 bits wide and controls the sequence in which the instructions stored in the program ROM are executed. The contents of the PC can specify a maximum of 2048 addresses.

After accessing a program memory word to fetch an instruction code, the contents of the program counter are incremented by one. The program counter then points to the memory word containing the next instruction code.

When executing a jump instruction, conditional skip execution, loading register, subroutine call or return from subroutine, initial reset, internal interrupt, external interrupt or return from interrupts, the PC manipulates the program transfer by loading the address corresponding to each instruction.

The conditional skip is activated by instructions. Once the condition is met, the next instruction, fetched during the current instruction execution, is discarded and a dummy cycle replaces it to get the proper instruction. Otherwise proceed to the next instruction.



Mode		Program Counter									
Wode	*b10	*b9	*b8	*b7	*b6	*b5	*b4	*b3	*b2	*b1	*b0
Initial Reset	0	0	0	0	0	0	0	0	0	0	0
External Interrupt	0	0	0	0	0	0	0	0	1	0	0
Timer/Event Counter Overflow	0	0	0	0	0	0	0	1	0	0	0
A/D Converter Interrupt	0	0	0	0	0	0	0	1	1	0	0
Skip	Program Counter+2										
Loading PCL	PC10	PC9	PC8	@7	@6	@5	@4	@3	@2	@1	@0
Jump, Call Branch	#10	#9	#8	#7	#6	#5	#4	#3	#2	#1	#0
Return from Subroutine	S10	S9	S8	S7	S6	S5	S4	S3	S2	S1	S0

#### Execution Flow

#### **Program Counter**

Note: \*b10~\*b0: Program counter bits

S10~S0: Stack register bits

#10~#0: Instruction code bits

@7~@0: PCL bits, PC10~PC8: Original PC counter, remain unchanged

For the HT46R51, since the program counter is 10 bits wide (b0 $\sim$ b9), the b10 columns in the table are not applicable.

For the HT46R52, since the program counter is 11 bits wide (b0~b10)



The lower byte of the PC (PCL) is a readable and writeable register (06H). Moving data into the PCL performs a short jump. The destination is within 256 locations.

When a control transfer takes place, an additional dummy cycle is required.

#### **Program Memory – EPROM**

The program memory is used to store the program instructions which are to be executed. It also contains data, table, and interrupt entries, and is organized into 1024×14 (HT46R51) or 2048×14 (HT46R52) bits, addressed by the Program Counter and table pointer.

Certain locations in the ROM are reserved for special usage:

Location 000H

This location is reserved for program initialization. After a chip reset, the program always begins execution at location 000H.

Location 004H

This location is reserved for the external interrupt service program. If the  $\overline{INT}$  input pin is activated, the interrupt is enabled and the stack is not full, the program begins execution at this location.

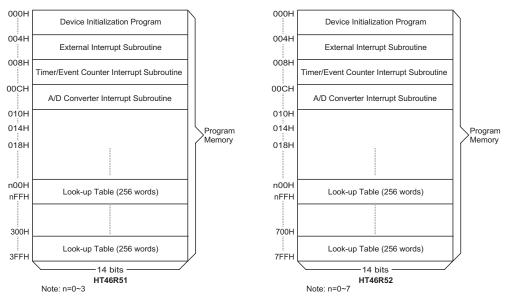
Location 008H

This location is reserved for the timer/event counter interrupt service program. If a timer interrupt results from a timer/event counter overflow, and the interrupt is enabled and the stack is not full, the program begins execution at location 008H. Location 00CH

Location 00CH is reserved for the A/D converter interrupt service program. If an A/D converter interrupt results from an end of A/D conversion, and if the interrupt is enabled and the stack is not full, the program begins execution at location 00CH.

Table location

Any location in the program memory can be used as look-up tables. The instructions "TABRDC [m]" (the current page) and "TABRDL [m]" (the last page) transfer the contents of the lower-order byte to the specified data memory, and the higher-order byte to TBLH (08H). The lower-order byte table pointer TBLP (07H) are read/write registers, which indicate the table locations. Before accessing the table, the location has to be placed in TBLP. The TBLH is read only and cannot be restored. If the main routine and the ISR (interrupt service routine) both employ the table read instruction, the contents of the TBLH in the main routine are likely to be changed by the table read instruction used in the ISR. Errors can occur. Given this, using the table read instruction in the main routine and the ISR simultaneously should be avoided. However, if the table read instruction has to be applied in both main routine and the ISR, the interrupt should be disabled prior to the table read instruction. It will not be enabled until the TBLH in the main routine has been backed-up. All table related instructions require 2 cycles to complete the operation.



Program Memory



Instruction					Tab	le Locat	ion				
Instruction	b10	b9	b8	b7	b6	b5	b4	b3	b2	b1	b0
TABRDC [m]	P10	P9	P8	@7	@6	@5	@4	@3	@2	@1	@0
TABRDL [m]	1	1	1	@7	@6	@5	@4	@3	@2	@1	@0

#### **Table Location**

Note: b10~b0: Table location bits

P10~P8: Current program counter bits

@7~@0: Table pointer bits

For the Ht46R51, since the program counter is 10 bits wide (b0~b9), the b10 column in the table are not applicable

For the HT46R52, since the program counter is 11 bits wide (b0~b10)

#### Stack Register – STACK

This is a special part of the memory which is used to save the contents of the program counter only. The stack is organized into 6 levels and is neither part of the data nor part of the program space, and is neither readable nor writeable. The activated level is indexed by the stack pointer (SP) and is neither readable nor writeable. At the state of a subroutine call or an interrupt acknowledgment, the contents of the program counter are pushed onto the stack. At the end of the subroutine or an interrupt routine, signaled by a return instruction (RET or RETI), the program counter is restored to its previous value from the stack. After a chip reset, the SP will point to the top of the stack.

If the stack is full and a non-masked interrupt takes place, the interrupt request flag will be recorded but the acknowledge signal will be inhibited. When the stack pointer is decremented (by RET or RETI), the interrupt is serviced. This feature prevents stack overflow, allowing the programmer to use the structure more easily. If the stack is full and a "CALL" is subsequently executed, stack overflow occurs and the first entry will be lost (only the most recent 6 return addresses are stored).

#### Data Memory - RAM

The data memory (RAM) is designed with 111×8 bits and is divided into two functional groups, namely; special function registers (23×8 bits) and general purpose data memory (88×8bit) most of which are readable/writable, although some are read only. Of the two types of functional groups, the special function registers consist of an Indirect addressing register 0 (00H), a Memory pointer register 0 (MP0;01H), an Indirect addressing register 1 (02H), a Memory pointer register 1 (MP1;03H), an Accumulator (ACC;05H), a Program counter lower-order byte register (PCL;06H), a Table pointer (TBLP;07H), a Table higher-order byte register (TBLH;08H), a Status register (STATUS;0AH), an Interrupt control register (INTC;0BH), a Timer/Event Counter (TMR:0DH), a Timer/Event Counter control register (TMRC;0EH), PWM data register (PWM;1AH), the A/D

00H	Indirect Addressing Register 0	$\mathbf{N}$
01H	MP0	
02H	Indirect Addressing Register 1	
03H	MP1	
04H		
05H	ACC	
06H	PCL	
07H	TBLP	
08H	TBLH	
09H		
0AH	STATUS	
0BH	INTC	
0CH		
0DH	TMR	
0EH	TMRC	
0FH		
10H		
11H		Special Purpose
12H	PA	DATA MEMORY
13H	PAC	
14H	PB	
15H	PBC	
16H		
17H		
18H	PD	
19H	PDC	
1AH	PWM	
1BH		
1CH		
1DH		
1EH		
1FH		
20H	ADRL	
21H	ADRH	
22H	ADCR	
23H	ACSR	
24H		ŕ
27H		
28H	General Purpose	: Unused
	Data Memory	Read as "00"
	(88 Bytes)	
7FH		

**RAM Mapping** 



result lower-order byte register (ADRL;20H), the A/D result higher-order byte register (ADRH;21H), the A/D control register (ADCR;22H), the A/D clock setting register (ACSR;23H), I/O registers (PA;12H, PB;14H, PD;18H) and I/O control registers (PAC;13H, PBC;15H, PDC;19H). The remaining space before the 28H is reserved for future expanded usage and reading these locations will return the result "00H". The general purpose data memory, addressed from 28H to 7FH, is used for data and control information under instruction commands. All of the data memory areas can handle arithmetic, logic, increment, decrement and rotate operations directly. Except for some dedicated bits, each bit in the data memory can be set and reset by "SET [m].i" and "CLR [m].i". They are also indirectly accessible through memory pointer registers (MP0;01H or MP1;03H).

#### Indirect Addressing Register

Location 00H and 02H are indirect addressing registers that are not physically implemented. Any read/write operation of [00H] ([02H]) will access the data memory pointed to by MP0 (MP1). Reading location 00H (02H) itself indirectly will return the result "00H". Writing indirectly results in no operation. The memory pointer registers (MP0 and MP1) are 7-bit registers.

#### Accumulator – ACC

The accumulator closely relates to ALU operations. It is also mapped to location "05H" of the data memory which can operate with immediate data. The data movement between two data memories has to pass through the accumulator.

#### Arithmetic and Logic Unit – ALU

This circuit performs 8-bit arithmetic and logic operations. The ALU provides the following functions:

- Arithmetic operations (ADD, ADC, SUB, SBC, DAA)
- · Logic operations (AND, OR, XOR, CPL)
- Rotation (RL, RR, RLC, RRC)
- Increment and Decrement (INC, DEC)
- Branch decision (SZ, SNZ, SIZ, SDZ ....)

The ALU not only saves the results of a data operation but also changes the status register.

#### Status Register – STATUS

This 8-bit register (0AH) contains the zero flag (Z), carry flag (C), auxiliary carry flag (AC), overflow flag (OV), power down flag (PDF), and watchdog time-out flag (TO). It also records the status information and controls the operation sequence.

With the exception of the TO and PDF flags, bits in the status register can be altered by instructions like most other registers. Any data written into the status register will not change the TO and PDF flags. Addition operations related to the status register may give different results from those intended. The TO flag can be affected only by system power-up, a WDT time-out or executing the "HALT" or "CLR WDT" instruction. The PDF flag can be affected only by executing the "HALT" or "CLR WDT" instruction or a system power-up.

The Z, OV, AC, and C flags reflect the status of the latest operations. On entering the interrupt sequence or executing the subroutine call, the status register will not be automatically pushed onto the stack. If the contents of the status is important, and if the subroutine is likely to corrupt the status register, the programmer should take precautions and save it properly.

#### Interrupts

The device provides an external interrupt, an internal timer/event counter interrupt, and an A/D converter interrupt. The interrupt control register (INTC;0BH) con-

Bit No.	Label	Function
0	С	C is set if an operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation; otherwise C is cleared. C is also affected by a rotate through carry instruction.
1	AC	AC is set if an operation results in a carry out of the low nibbles in addition or no borrow from the high nibble into the low nibble in subtraction; otherwise AC is cleared.
2	Z	Z is set if the result of an arithmetic or logic operation is zero; otherwise Z is cleared.
3	OV	OV is set if an operation results in a carry into the highest-order bit but not a carry out of the highest-order bit, or vice versa; otherwise OV is cleared.
4	PDF	PDF is cleared by system power-up or executing the "CLR WDT" instruction. PDF is set by executing the "HALT" instruction.
5	то	TO is cleared by system power-up or executing the "CLR WDT" or "HALT" instruction. TO is set by a WDT time-out.
6, 7		Unused bit, read as "0"

#### Status (0AH) Register



tains the interrupt control bits to set the enable/disable and the interrupt request flags.

Once an interrupt subroutine is serviced, all the other interrupts will be blocked (by clearing the EMI bit). This scheme may prevent any further interrupt nesting. Other interrupt requests may occur during this interval but only the interrupt request flag is recorded. If a certain interrupt requires servicing within the service routine, the EMI bit and the corresponding bit of the INTC may be set to allow interrupt nesting. If the stack is full, the interrupt request will not be acknowledged, even if the related interrupt is enabled, until the SP is decremented. If immediate service is desired, the stack must be prevented from becoming full.

All these kinds of interrupts have a wake-up capability. As an interrupt is serviced, a control transfer occurs by pushing the program counter onto the stack, followed by a branch to a subroutine at specified location in the program memory. Only the program counter is pushed onto the stack. If the contents of the register or status register (STATUS) are altered by the interrupt service program which corrupts the desired control sequence, the contents should be saved in advance.

External interrupts are triggered by a high to low transition of  $\overline{\text{INT}}$  and the related interrupt request flag (EIF; bit 4 of the INTC) will be set. When the interrupt is enabled, the stack is not full and the external interrupt is active, a subroutine call to location "04H" will occur. The interrupt request flag (EIF) and EMI bits will be cleared to disable other interrupts.

The internal Timer/Event Counter interrupt is initialized by setting the Timer/Event Counter interrupt request flag (TF; bit 5 of the INTC), which is normally caused by a timer overflow. After the interrupt is enabled, and the stack is not full, and the TF bit is set, a subroutine call to location "08H" occurs. The related interrupt request flag (TF) is reset, and the EMI bit is cleared to disable further maskable interrupts.

The A/D converter interrupt is initialized by setting the A/D converter request flag (ADF; bit 6 of the INTC), caused by an end of A/D conversion. When the interrupt is enabled, the stack is not full and the ADF is set, a sub-

routine call to location "0CH" will occur. The related interrupt request flag (ADF) will be reset and the EMI bit cleared to disable further interrupts.

During the execution of an interrupt subroutine, other interrupt acknowledgments are held until the "RETI" instruction is executed or the EMI bit and the related interrupt control bit are set to 1 (if the stack is not full). To return from the interrupt subroutine, "RET" or "RETI" may be invoked. RETI will set the EMI bit to enable an interrupt service, but RET will not.

Interrupts, occurring in the interval between the rising edges of two consecutive T2 pulses, will be serviced on the latter of the two T2 pulses, if the corresponding interrupts are enabled. In the case of simultaneous requests the following table shows the priority that is applied. These can be masked by resetting the EMI bit.

Interrupt Source	Priority	Vector
External Interrupt	1	04H
Timer/Event Counter Overflow	2	08H
A/D Converter Interrupt	3	0CH

The timer/event counter interrupt request flag (TF), external interrupt request flag (EIF), A/D converter request flag (ADF), enable timer/event counter bit (ETI), enable external interrupt bit (EEI), enable A/D converter interrupt bit (EADI), and enable master interrupt bit (EMI) constitute an interrupt control register (INTC) which are located at "0BH" in the data memory. EMI, EEI, ETI, and EADI are used to control the enabling/disabling of interrupts. These bits prevent the requested interrupt from being serviced. Once the interrupt request flags (TF, EIF, and ADF) are set, they will remain in the INTC register until the interrupts are serviced or cleared by a software instruction.

It is recommended that a program does not use the "CALL subroutine" within the interrupt subroutine. Interrupts often occur in an unpredictable manner or need to be serviced immediately in some applications. If only one stack is left and enabling the interrupt is not well controlled, the original control sequence will be damaged once the "CALL" operates in the interrupt subroutine.

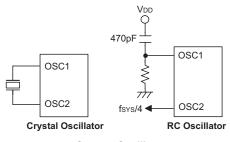
Bit No.	Label	Function
0	EMI	Controls the master (global) interrupt (1= enable; 0= disable)
1	EEI	Controls the external interrupt (1= enable; 0= disable)
2	ETI	Controls the Timer/Event Counter interrupt (1= enable; 0= disable)
3	EADI	Control the A/D converter interrupt (1= enable; 0= disable)
4	EIF	External interrupt request flag (1= active; 0= inactive)
5	TF	Internal Timer/Event Counter request flag (1= active; 0= inactive)
6	ADF	A/D converter request flag (1= active; 0= inactive)
7		For test mode used only. Must be written as "0"; otherwise may result in unpredictable operation.

#### INTC (0BH) Register



#### **Oscillator Configuration**

There are two oscillator circuits in the microcontroller.



System Oscillator

Both of them are designed for system clocks, namely the external RC oscillator and the external Crystal oscillator, which are determined by options. No matter what oscillator type is selected, the signal provides the system clock. The HALT mode stops the system oscillator and ignores an external signal to conserve power.

If an RC oscillator is used, an external resistor between OSC1 and VSS is required and the resistance must range from  $30k\Omega$  to  $750k\Omega$ . The system clock, divided by 4, is available on OSC2 with pull-high resistor, which can be used to synchronize external logic. The RC oscillator provides the most cost effective solution. However, the frequency of oscillation may vary with VDD, temperatures and the chip itself due to process variations. It is therefore not suitable for timing sensitive operations where an accurate oscillator frequency is desired.

If the Crystal oscillator is used, a crystal across OSC1 and OSC2 is needed to provide the feedback and phase shift required for the oscillator, and no other external components are required. Instead of a crystal, a resonator can also be connected between OSC1 and OSC2 to get a frequency reference, but two external capacitors in OSC1 and OSC2 are required (If the oscillator can be disabled by options to conserve power).

The WDT oscillator is a free running on-chip RC oscillator, and no external components are required. Even if the system enters the power down mode, the system clock is stopped, but the WDT oscillator still works with a period of approximately  $65\mu$ s at 5V. The WDT oscillator can be disabled by option to conserve power.

#### Watchdog Timer – WDT

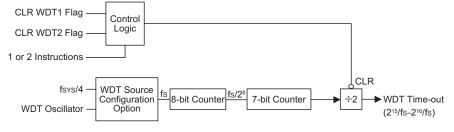
The clock source of the WDT is implemented by a dedicated RC oscillator (WDT oscillator) or instruction clock (system clock divided by 4) decided by options. This timer is designed to prevent a software mal-function or sequence jumping to an unknown location with unpredictable results. The watchdog timer can be disabled by an option. If the watchdog timer is disabled, all the executions related to the WDT result in no operation.

The WDT clock ( $f_S$ ) is further divided by an internal counter to give longer watchdog time-outs. The division ratio is fixed by an internal counter which gives a  $2^{15}$  fixed division ratio.

Once an internal WDT oscillator (RC oscillator with period of  $65\mu s$  normally) is selected, it is divided by  $2^{16}$  to get the time-out period of approximately 4.3s. This time-out period may vary with temperature, VDD and process variations.

If the WDT oscillator is disabled, the WDT clock may still come from the instruction clock and operate in the same manner except that in the HALT state the WDT may stop counting and lose its protecting purpose. In this situation the logic can only be restarted by external logic. If the device operates in a noisy environment, using the on-chip RC oscillator (WDT OSC) is strongly recommended, since the HALT will stop the system clock.

The WDT overflow under normal operation will initialize a "chip reset" and set the status bit TO. Whereas in the HALT mode, the overflow will initialize a "warm reset" wherein only the Program Counter and SP are reset to zero. To clear the contents of the WDT, three methods are adopted; external reset (a low level to RES), software instructions, or a HALT instruction. The software instructions include "CLR WDT" and the other set CLR WDT1 and CLR WDT2. Of these two types of instruction, only one can be active depending on the option -"CLR WDT times selection option". If the "CLR WDT" is selected (i.e. CLRWDT times equal one), any execution of the CLR WDT instruction will clear the WDT. In case "CLR WDT1" and "CLR WDT2" are chosen (i.e. CLRWDT times equal two), these two instructions must be executed to clear the WDT; otherwise, the WDT may reset the chip because of time-out.



Watchdog Timer

The WDT time-out period is fixed to  $f_s/2^{16}$ , because the "CLR WDT" or "CLR WDT1" and "CLR WDT2" instructions will clear the whole counter of the WDT.

#### Power Down Operation – HALT

The HALT mode is initialized by the "HALT" instruction and results in the following...

- The system oscillator is turned off but the WDT oscillator keeps running (if the WDT oscillator or the real time clock is selected).
- The contents of the on-chip RAM and registers remain unchanged
- The WDT and WDT prescaler will be cleared to zero. If the WDT clock source is from the RTC/WDT oscillator, the WDT will remain active, and if the WDT clock source is  $f_{SYS}/4$ , the WDT will stop running.
- All of the I/O ports maintain their original status
- The PDF flag is set and the TO flag is cleared

The system quits the HALT mode by way of an external reset, an interrupt, an external falling edge signal on port A or a WDT overflow. An external reset causes a device initialization and the WDT overflow performs a "warm reset". After examining the TO and PDF flags, the cause for a chip reset can be determined. The PDF flag is cleared by system power-up or by executing the "CLR WDT" instruction and is set when executing the "HALT" instruction. On the other hand, the TO flag is set if the WDT time-out occurs, and causes a wake-up that only resets the Program Counter and SP, and leaves the others in their original status.

The port A wake-up and interrupt methods can be considered as a continuation of normal execution. Each bit in port A can be independently selected to wake-up the device by options. Awakening from an I/O port stimulus, the program resumes execution of the next instruction. On the other hand, awakening from an interrupt, two sequence may occur. If the related interrupt is disabled or the interrupt is enabled but the stack is full, the program resumes execution at the next instruction. But if the interrupt is enabled, and the stack is not full, the regular interrupt response takes place. When an interrupt request flag is set before entering the "HALT" status, the system cannot be awakened using that interrupt. If wake-up events occur, it takes 1024 t<sub>SYS</sub> (system clock period) to resume normal operation. In other words, a dummy period is inserted after the wake-up. If the wake-up results from an interrupt acknowledgment, the actual interrupt subroutine execution is delayed by more than one cycle. However, if the Wake-up results in the next instruction execution, the execution will be performed immediately after the dummy period is finished.

To minimize power consumption, all the I/O pins should be carefully managed before entering the HALT status.

#### Reset

There are three ways in which a reset may occur:

- RES reset during normal operation
- RES reset during HALT
- WDT time-out reset during normal operation

The WDT time-out during HALT differs from other chip reset conditions, for it can perform a "warm reset" that resets only the Program Counter and SP, leaving the other circuits at their original state. Some registers remain unaffected during any other reset conditions. Most registers are reset to the "initial condition" when the reset conditions are met. Examining the PDF and TO flags, the program can distinguish between different "chip resets".

то	PDF	<b>RESET Conditions</b>			
0	0	RES reset during power-up			
u	u	RES reset during normal operation			
0	1	RES wake-up HALT			
1	u	WDT time-out during normal operation			
1	1	WDT wake-up HALT			

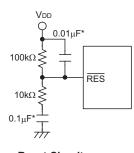
Note: "u" stands for "unchanged"

To guarantee that the system oscillator is started and stabilized, the SST (System Start-up Timer) provides an extra-delay of 1024 system clock pulses when the system reset (power-up, WDT time-out or  $\overrightarrow{\text{RES}}$  reset) or the system awakes from the HALT state. When a system reset occurs, the SST delay is added during the reset period. Any wake-up from the HALT will enable the SST delay. An extra option load time delay is added during system reset (Power-up, WDT time-out at normal mode or  $\overrightarrow{\text{RES}}$  reset).

The functional unit chip reset status are shown below.

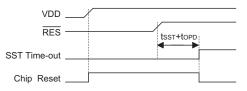
Program Counter	000H
Interrupt	Disable
Prescaler, Divider	Cleared
WDT	Clear. After master reset, WDT begins counting
Timer/Event Counter	Off
Input/Output Ports	Input mode
Stack Pointer	Points to the top of the stack



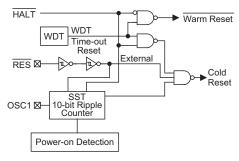


Reset Circuit

Note: "\*" Make the length of the wiring, which is connected to the RES pin as short as possible, to avoid noise interference.



**Reset Timing Chart** 



**Reset Configuration** 

Register	Reset(Power On)	WDT Time-out (Normal Operation)	RES Reset (Normal Operation)	RES Reset (HALT)	WDT Time-out (HALT)*	
TMR	XXXX XXXX	XXXX XXXX	XXXX XXXX	XXXX XXXX	นนนน นนนน	
TMRC	00-0 1000	00-0 1000	00-0 1000	00-0 1000	uu-u uuuu	
Program Counter	0000H	0000H	0000H	0000H	0000H	
MP0	-xxx xxxx	-xxx xxxx	-xxx xxxx	-xxx xxxx	-uuu uuuu	
MP1	-xxx xxxx	-xxx xxxx	-xxx xxxx	-xxx xxxx	-uuu uuuu	
ACC	XXXX XXXX	นนนน นนนน	นนนน นนนน	นนนน นนนน	นนนน นนนน	
TBLP	XXXX XXXX	นนนน นนนน	սսսս սսսս	นนนน นนนน	นนนน นนนน	
TBLH	XXXX XXXX	นนนน นนนน	սսսս սսսս	นนนน นนนน	นนนน นนนน	
STATUS	00 xxxx	1u uuuu	uu uuuu	01 uuuu	11 uuuu	
INTC	-000 0000	-000 0000	-000 0000	-000 0000	-uuu uuuu	
PA	1111 1111	1111 1111	1111 1111	1111 1111	นนนน นนนน	
PAC	1111 1111	1111 1111	1111 1111	1111 1111	นนนน นนนน	
РВ	1 1111	1 1111	1 1111	1 1111	u uuuu	
PBC	1 1111	1 1111	1 1111	1 1111	u uuuu	
PD	1	1	1	1	u	
PDC	1	1	1	1	u	
PWM	XXXX XXXX	XXXX XXXX	XXXX XXXX	XXXX XXXX	นนนน นนนน	
ADRL	xxxx	xxxx	xxxx	xxxx	uuuu	
ADRH	XXXX XXXX	XXXX XXXX	XXXX XXXX	XXXX XXXX	นนนน นนนน	
ADCR	0100 0000	0100 0000	0100 0000	0100 0000	นนนน นนนน	
ACSR	00	00	00	00	uu	

The register states are summarized below:

Note: "\*" stands for "warm reset" "u" stands for "unchanged" "x" stands for "unknown"



#### **Timer/Event Counter**

Only one timer/event counter (TMR) are implemented in the microcontroller. The timer/event counter contains an 8-bit programmable count-up counter and the clock may come from an external source or an internal clock source. An internal clock source comes from  $f_{SYS}$ . The external clock input allows the user to count external events, measure time intervals or pulse widths, or to generate an accurate time base.

There are two registers related to the Timer/event counter; TMR (0DH), TMRC (0EH). Writing TMR will transfer the specified data to timer/event counter registers. Reading the TMR will read the contents of the timer/event counter. The TMRC is a control register, which defines the operating mode, counting enable or disable and an active edge.

The TM0 and TM1 bits define the operation mode. The event count mode is used to count external events, which means that the clock source is from an external (TMR) pin. The timer mode functions as a normal timer with the clock source coming from the internal selected clock source. Finally, the pulse width measurement mode can be used to count the high or low level duration of the external signal (TMR), and the counting is based on the internal selected clock source.

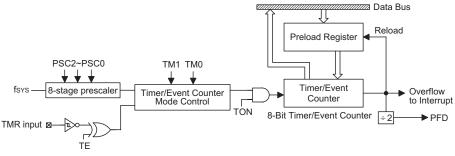
In the event count or timer mode, the timer/event counter starts counting at the current contents in the timer/event counter and ends at FFH. Once an overflow occurs, the counter is reloaded from the timer/event counter preload register, and generates an interrupt request flag (TF; bit 5 of the INTC ). In the pulse width measurement mode with the values of the TON and TE bits equal to 1, after the TMR has received a transient from low to high (or high to low if the TE bit is "0"), it will start counting until the TMR returns to the original level and resets the TON. The measured result remains in the timer/event counter even if the activated transient occurs again. In other words, only 1-cycle measurement can be made until the TON is set. The cycle measurement will re-operate as long as it receives further transient pulse. In this operation mode, the timer/event counter begins counting not according to the logic level but to the transient edges. In the case of counter overflows, the counter is reloaded from the timer/event counter register and issues an interrupt request, as in the other two modes, i.e., event and timer modes.

To enable the counting operation, the Timer ON bit (TON; bit 4 of the TMRC) should be set to "1". In the pulse width measurement mode, the TON is automatically cleared after the measurement cycle is completed. But in the other two modes, the TON can only be reset by instructions. The overflow of the timer/event counter is one of the wake-up sources and can also be applied to a PFD (Programmable Frequency Divider) output at PA3 by options. No matter what the operation mode is, writing a "0" to ETI (bit2 of the INTC) disables the related interrupt service. When the PFD function is selected, executing "SET [PA].3" instruction to enable the PFD output and executing "CLR [PA].3" instruction to disable the PFD output.

In the case of timer/event counter OFF condition, writing data to the timer/event counter preload register also reloads that data to the timer/event counter. But if the timer/event counter is turn on, data written to the timer/event counter is kept only in the timer/event counter preload register. The timer/event counter still continues its operation until an overflow occurs.

When the timer/event counter (TMR) is read, the clock is blocked to avoid errors, as this may results in a counting error. Blocking of the clock issue should be taken into account by the programmer. It is strongly recommended to load a desired value into the TMR register first, before turning on the related timer/event counter, for proper operation since the initial value of TMR is unknown. Due to the timer/event scheme, the programmer should pay special attention on the instruction to enable then disable the timer for the first time, whenever there is a need to use the timer/event function, to avoid unpredictable result. After this procedure, the timer/event function can be operated normally.

The bit0~bit2 of the TMRC can be used to define the pre-scaling stages of the internal clock sources of the timer/event counter. The definitions are as shown. The overflow signal of the timer/event counter can be used to generate the PFD signal. The timer prescaler is also used as the PWM counter.



8-Bit Timer/Event Counter Structure



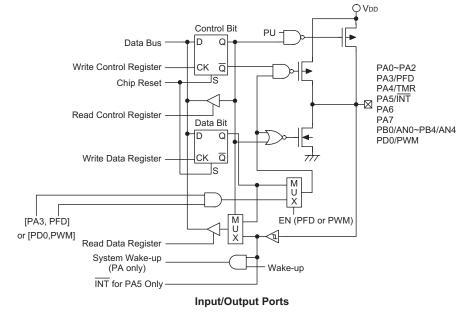
Bit No.	Label	Function
0 1 2	PSC0 PSC1 PSC2	$ \begin{array}{l} \mbox{Defines the prescaler stages, PSC2, PSC1, PSC0=} \\ 000: f_{INT}=f_{SYS} \\ 001: f_{INT}=f_{SYS}/2 \\ 010: f_{INT}=f_{SYS}/4 \\ 011: f_{INT}=f_{SYS}/8 \\ 100: f_{INT}=f_{SYS}/16 \\ 101: f_{INT}=f_{SYS}/32 \\ 110: f_{INT}=f_{SYS}/64 \\ 111: f_{INT}=f_{SYS}/128 \\ \end{array} $
3	TE	Defines the TMR active edge of the timer/event counter: In Event Counter Mode (TM1,TM0)=(0,1): 1:count on falling edge; 0:count on rising edge In Pulse Width measurement mode (TM1,TM0)=(1,1): 1: start counting on the rising edge, stop on the falling edge; 0: start counting on the falling edge, stop on the rising edge
4	TON	Enable/disable timer counting (0=disable; 1=enable)
5	_	Unused bit, read as "0"
6 7	TM0 TM1	Defines the operating mode, TM1, TM0: 01=Event count mode (external clock) 10=Timer mode (internal clock) 11=Pulse width measurement mode 00=Unused

#### TMRC (0EH) Register

#### Input/Output Ports

There are 14 bidirectional input/output lines in the microcontroller, labeled as PA, PB and PD, which are mapped to the data memory of [12H], [14H] and [18H] respectively. All of these I/O ports can be used for input and output operations. For input operation, these ports are non-latching, that is, the inputs must be ready at the T2 rising edge of instruction "MOV A,[m]" (m=12H, 14H or 18H). For output operation, all the data is latched and remains unchanged until the output latch is rewritten.

Each I/O line has its own control register (PAC, PBC, PDC) to control the input/output configuration. With this control register, CMOS output or Schmitt trigger input with or without pull-high resistor structures can be reconfigured dynamically under software control. To function as an input, the corresponding latch of the control register must write "1". The input source also depends on the control register. If the control register bit is "1", the input will read the pad state. If the control register bit





is "0", the contents of the latches will move to the internal bus. The latter is possible in the "read-modify-write" instruction.

For output function, CMOS is the only configuration. These control registers are mapped to locations 13H, 15H and 19H.

After a chip reset, these input/output lines remain at high levels or floating state (dependent on pull-high options). Each bit of these input/output latches can be set or cleared by "SET [m].i" and "CLR [m].i" (m=12H, 14H or 18H) instructions.

Some instructions first input data and then follow the output operations. For example, "SET [m].i", "CLR [m].i", "CPL [m]", "CPLA [m]" read the entire port states into the CPU, execute the defined operations (bit-operation), and then write the results back to the latches or the accumulator.

Each line of port A has the capability of waking-up the device. Each I/O port has a pull-high option. Once the pull-high option is selected, the I/O port has a pull-high resistor, otherwise, there's none. Take note that a non-pull-high I/O port operating in input mode will cause a floating state.

The PA3, PA4 and PA5 are pin-shared with PFD, TMR and  $\overline{\text{INT}}$  pins respectively.

If the PFD option is selected, the output signal in output mode of PA3 will be the PFD signal generated by the timer/event counter overflow signal. The input mode always remain in its original functions. Once the PFD option is selected, the PFD output signal is controlled by the PA3 data register only. The I/O functions of PA3 are shown below.

I/O	l/P	O/P	l/P	O/P
Mode	(Normal)	(Normal)	(PFD)	(PFD)
PA3	Logical Input	Logical Output	Logical Input	

Note: The PFD frequency is the timer/event counter overflow frequency divided by 2.

<u>.</u>				
Timer	Timer Preload Value	PA3 Data Register	PA3 Pad State	Frequency
OFF	Х	0	0	Х
OFF	Х	1	U	Х
ON	N	0	0	Х
ON	N	1	PFD	f <sub>INT</sub> /(2×(256-N))

The definitions of the PFD control signal and PFD output frequency are listed in the following table.

Note: "X" stands for "unused"

"U" stands for "unknown"

"N" is the preload value for the timer/event counter

 $"f_{\mathsf{TMR}}"$  is the input clock frequency for the timer/event counter

The PB can also be used as A/D converter inputs. The A/D function will be described later. There is a PWM function shared with PD0. If the PWM function is enabled, the PWM signal will appear on PD0 (if PD0 is operating in output mode). The I/O functions of PD0 are as shown.

I/O	l/P	O/P	I/P	O/P
Mode	(Normal)	(Normal)	(PWM)	(PWM)
PD0	Logical Input	Logical Output	Logical Input	

It is recommended that unused or not bonded out I/O lines should be set as output pins by software instruction to avoid consuming power under input floating state.

#### PWM

The microcontroller provides one channel PWM output shared with PD0. The PWM supports 6+2 mode. The PWM channel has their data register denoted as PWM(1AH). The frequency source of the PWM counter comes from  $f_{SYS}$ . The PWM register is an 8-bit register. The waveforms of the PWM outputs are as shown. Once the PD0 are selected as the PWM outputs and the output function of the PD0 are enabled (PDC.0= "0"), writing "1" to PD0 data register will enable the PWM output function and writing "0" will force the PD0 to stay at "0".

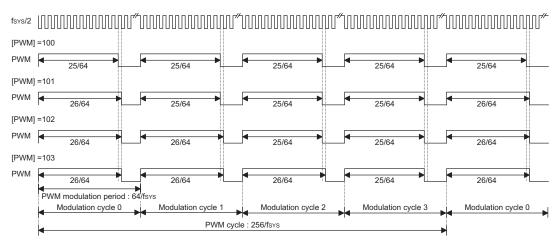
A (6+2) bits mode PWM cycle is divided into four modulation cycles (modulation cycle 0~modulation cycle 3). Each modulation cycle has 64 PWM input clock period. In a (6+2) bit PWM function, the contents of the PWM register is divided into two groups. Group 1 of the PWM register is denoted by DC which is the value of PWM.7~PWM.2. The group 2 is denoted by AC which is the value of PWM.1~PWM.0. In a (6+2) bits mode PWM cycle, the duty cycle of each modulation cycle is shown in the table.

Parameter	AC (0~3)	Duty Cycle
Modulation cycle i (i=0~3)	i <ac< td=""><td>DC+1 64</td></ac<>	DC+1 64
	i≥AC	DC 64

The modulation frequency, cycle frequency and cycle duty of the PWM output signal are summarized in the following table.

		PWM Cycle Frequency	PWM Cycle Duty
1	f <sub>SYS</sub> /64 for (6+2) bits mode	f <sub>SYS</sub> /256	[PWM]/256







#### A/D Converter

The 5 channels 12-bit resolution A/D converter are implemented in this microcontroller.

The A/D converter contains 4 special registers which are; ADRL (20H), ADRH (21H), ADCR (22H) and ACSR (23H). The ADRH and ADRL are A/D result register higher-order byte and lower-order byte and are read-only. After the A/D conversion is completed, the ADRH and ADRL should be read to get the conversion result data. The ADCR is an A/D converter control register, which defines the A/D channel number, analog channel select, start A/D conversion control bit and the end of A/D conversion flag. If the users want to start an A/D conversion, define PB configuration, select the converted analog channel, and give START bit a raising edge and falling edge  $(0 \rightarrow 1 \rightarrow 0)$ . At the end of A/D conversion, the EOCB bit is cleared and an A/D converter interrupt occurs (if the A/D converter interrupt is enabled). The ACSR is A/D clock setting register, which is used to select the A/D clock source.

The A/D converter control register is used to control the A/D converter. The bit2~bit0 of the are used to select an analog input channel. There are a total of five channels to select. The bit5~bit3 of the ADCR are used to set PB configurations. PB can be an analog input or as digital I/O line determined by these 3 bits. Once a PB line is selected as an analog input, the I/O functions and pull-high resistor of this I/O line are disabled and the A/D converter circuit is powered on. The EOCB bit (bit6 of the ADCR) is end of A/D conversion flag. Check this bit to know when the A/D conversion is completed.

The START bit of the ADCR is used to begin the conversion of the A/D converter. Giving START bit a rising edge and falling edge means that the A/D conversion has started. In order to ensure that the A/D conversion is completed, the START should remain at "0" until the EOCB is cleared to "0" (end of A/D conversion). The bit 7 of the ACSR is used for testing purposes only. Bit 7 of the ACSR register is used for test purposes only and must not be used for other purposes by the application program. Bit1 and bit0 of the ACSR register are used to select the A/D clock source.

When the A/D conversion has completed, the A/D interrupt request flag will be set. The EOCB bit is set to "1" when the START bit is set from "0" to "1".

Important Note for A/D initialisation:

Special care must be taken to initialise the A/D converter each time the Port B A/D channel selection bits are modified, otherwise the EOCB flag may be in an undefined condition. An A/D initialisation is implemented by setting the START bit high and then clearing it to zero within 10 instruction cycles of the Port B channel selection bits being modified. Note that if the Port B channel selection bits are all cleared to zero then an A/D initialisation is not required.

Bit No.	Label	Function
0 1	ADCS0 ADCS1	Selects the A/D converter clock source 00= system clock/2 01= system clock/8 10= system clock/32 11= undefined
2~6	_	Unused bit, read as "0"
7	TEST	For test mode used only

ACSR (23H) Register



Bit No.	Label	Function			
0 1 2	ACS0 ACS1 ACS2	Defines the analog channel select			
3 4 5	PCR0 PCR1 PCR2	Defines the port B configuration s lect. If PCR0, PCR1 and PCR2 are a zero, the ADC circuit is powered off reduce power consumption			
6	EOCB	Indicates end of A/D conversion. (0= end of A/D conversion) Each time bits 3~5 change state the A/D should be initialised by issuing a START signal, otherwise the EOCB flag may have an undefined condition. See "Important note for A/D initialis- ation".			
7	START	Starts the A/D conversion. $0\rightarrow 1\rightarrow 0$ = Start $0\rightarrow 1$ = Reset A/D converter and set EOCB to "1".			

ADCR (22H) Register

ACS2	ACS1	ACS0	Analog Channel
0	0	0	AN0
0	0	1	AN1
0	1	0	AN2
0	1	1	AN3
1	0	0	AN4
1	0	1	*
1	1	0	*
1	1	1	*

#### **Analog Input Channel Selection**

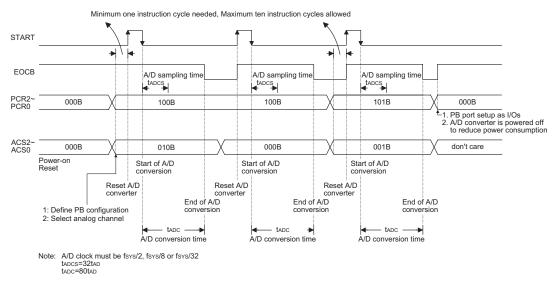
Note: \* undefined, cannot be used

Register	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ADRL (20H)	D3	D2	D1	D0	0	0	0	0
ADRH (21H)	D11	D10	D9	D8	D7	D6	D5	D4

Note: D0~D11 is A/D conversion result data bit LSB~MSB.

PCR2	PCR1	PCR0	4	3	2	1	0
0	0	0	PB4	PB3	PB2	PB1	PB0
0	0	1	PB4	PB3	PB2	PB1	AN0
0	1	0	PB4	PB3	PB2	AN1	AN0
0	1	1	PB4	PB3	AN2	AN1	AN0
1	0	0	PB4	AN3	AN2	AN1	AN0
1	0	1	AN4	AN3	AN2	AN1	AN0
1	1	0		Lindof	inad connot be	- used	
1	1	1		Under	ined, cannot be	e useu	

#### **Port B Configuration**



#### A/D Conversion Timing



The following two programming examples illustrate how to setup and implement an A/D conversion. In the first example, the method of polling the EOCB bit in the ADCR register is used to detect when the conversion cycle is complete, whereas in the second example, the A/D interrupt is used to determine when the conversion is complete.

Example: using EOCB Polling Method to detect end of conversion

	clr mov	EADI a,00000001B	; disable ADC interrupt
	mov	ACSR,a	; setup the ACSR register to select $f_{\mbox{\scriptsize SYS}}/8$ as the A/D clock
	mov mov	a,00100000B ADCR,a	; setup ADCR register to configure Port PB0~PB3 as A/D inputs ; and select AN0 to be connected to the A/D converter
	mov	:	
		:	; As the Port B channel bits have changed the following START ; signal (0-1-0) must be issued within 10 instruction cycles
Sta	rt conve	: ersion:	
010	clr	START	
	set	START	; reset A/D
Dol	clr ling EO	START	; start A/D
F01	ling_EO sz	EOCB	; poll the ADCR register EOCB bit to detect end of A/D conversion
	jmp	polling_EOC	; continue polling
	mov	a,ADRH	; read conversion result high byte value from the ADRH register
	mov	adrh_buffer,a	; save result to user defined memory
	mov mov	a,ADRL adrl_buffer,a	; read conversion result low byte value from the ADRL register ; save result to user defined memory
	mov	:	
	imn	: Start conversion	; start next A/D conversion
	jmp	Start_conversion	, start next A/D conversion
Exa		•	detect end of conversion
	clr mov	EADI a,00000001B	; disable ADC interrupt
	mov	ACSR,a	; setup the ACSR register to select $f_{\mbox{\scriptsize SYS}}/8$ as the A/D clock
	mov mov	a,00100000B ADCR,a	; setup ADCR register to configure Port PB0~PB3 as A/D inputs ; and select AN0 to be connected to the A/D converter
			; As the Port B channel bits have changed the following START ; signal (0-1-0) must be issued within 10 instruction cycles
Sta	rt conve	ersion:	
	clr	START	
	set	START	; reset A/D
	clr clr	START ADF	; start A/D ; clear ADC interrupt request flag
	set	EADI	; enable ADC interrupt
	set	EMI	; enable global interrupt
		:	
	DC interi C_ISR:	rupt service routine	
	mov mov	acc_stack,a a,STATUS	; save ACC to user defined memory
	mov	status_stack,a	; save STATUS to user defined memory
	mov	a,ADRH	; read conversion result high byte value from the ADRH register
	mov	adrh_buffer,a a,ADRL	; save result to user defined register
	mov mov	adrl_buffer,a	; read conversion result low byte value from the ADRL register ; save result to user defined register
	clr	START	
	set	START	; reset A/D
	clr	START	; start A/D
		•	



EXIT\_INT\_ISR: mov a,status\_stack mov STATUS,a mov a,acc\_stack reti

; restore STATUS from user defined memory

; restore ACC from user defined memory

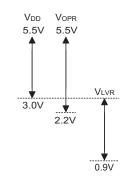
#### Low Voltage Reset – LVR

There is a low voltage reset circuit (LVR) implemented in the microcontrollers. The function can be enabled/disabled by options.

If the supply voltage of the device is within the range  $0.9V \sim V_{LVR}$  such as changing a battery, the LVR will automatically reset the device internally.

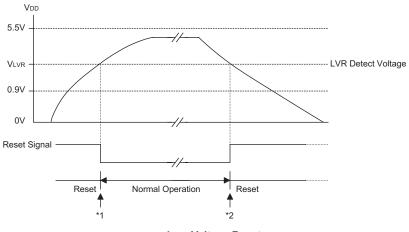
The LVR includes the following specifications:

- The low voltage (0.9V~V\_{LVR}) has to remain in their original state to exceed 1ms. If the low voltage state does not exceed 1ms, the LVR will ignore it and do not perform a reset function.
- The LVR uses the "OR" function with the external RES signal to perform chip reset.



The relationship between  $V_{DD}$  and  $V_{LVR}$  is shown below.

Note: V<sub>OPR</sub> is the voltage range for proper chip operation at 4MHz system clock.



Low Voltage Reset

- Note: \*1: To make sure that the system oscillator has stabilized, the SST provides an extra delay of 1024 system clock pulses before entering the normal operation.
  - \*2: Since low voltage state has to be maintained in its original state for over 1ms, therefore after 1ms delay, the device enters the reset mode.



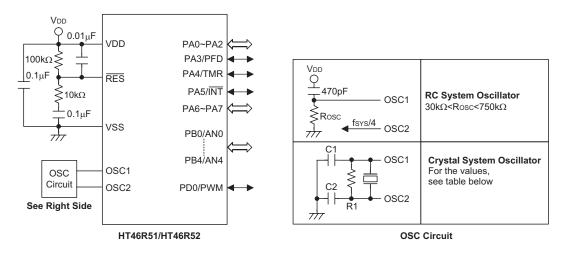
# Options

The following shows kinds of options in the device. ALL the options must be defined to ensure having a proper functioning system.

Options
OSC type selection. This option is to decide if an RC or crystal oscillator is chosen as system clock.
WDT source selection. There are three types of selection: on-chip RC oscillator, instruction clock or disable the WDT.
CLRWDT times selection. This option defines how to clear the WDT by instruction. "One time" means that the "CLR WDT" instruction can clear the WDT. "Two times" means only if both of the "CLR WDT1" and "CLR WDT2" instructions have been executed, then WDT can be cleared.
Wake-up selection. This option defines the wake-up function activity. External I/O pins (PA only) all have the capability to wake-up the chip from a HALT by a falling edge. (Bit option)
Pull-high selection. This option is to decide whether a pull-high resistance is visible or not in the input mode of the I/O ports. PA, PB and PD are bit option.
PFD selection. PA3: Level output or PFD output.
PWM selection. PD0: level output or PWM output
LVR selection. Enable or disable LVR function.



# **Application Circuits**



The following table shows the C1, C2 and R1 values corresponding to the different crystal values. (For reference only)

Crystal or Resonator	C1, C2	R1
4MHz Crystal	0pF	10kΩ
4MHz Resonator	10pF	12kΩ
3.58MHz Crystal	0pF	10kΩ
3.58MHz Resonator	25pF	10kΩ
2MHz Crystal & Resonator	25pF	10kΩ
1MHz Crystal	35pF	27kΩ
480kHz Resonator	300pF	9.1kΩ
455kHz Resonator	300pF	10kΩ
429kHz Resonator	300pF	10kΩ
The function of the resistor R1 is to ens	sure that the oscillator will switch off	should low voltage conditions occur

The function of the resistor R1 is to ensure that the oscillator will switch off should low voltage conditions occur. Such a low voltage, as mentioned here, is one which is less than the lowest value of the MCU operating voltage. Note however that if the LVR is enabled then R1 can be removed.

Note: The resistance and capacitance for reset circuit should be designed in such a way as to ensure that the VDD is stable and remains within a valid operating voltage range before bringing RES to high.

"\*" Make the length of the wiring, which is connected to the RES pin as short as possible, to avoid noise interference.



# Instruction Set Summary

Mnemonic	Description	Instruction Cycle	Flag Affected
Arithmetic			
ADD A,[m] ADDM A,[m] ADD A,x ADC A,[m]	Add data memory to ACC Add ACC to data memory Add immediate data to ACC Add data memory to ACC with carry	1 1 <sup>(1)</sup> 1 1	Z,C,AC,OV Z,C,AC,OV Z,C,AC,OV Z,C,AC,OV
ADCM A,[m] SUB A,x SUB A,[m] SUBM A,[m]	Add ACC to data memory with carry Subtract immediate data from ACC Subtract data memory from ACC Subtract data memory from ACC with result in data memory	$ \begin{array}{c} 1^{(1)} \\ 1 \\ 1^{(1)} \\ 1^{(1)} \\ 1 \end{array} $	Z,C,AC,OV Z,C,AC,OV Z,C,AC,OV Z,C,AC,OV
SBC A,[m] SBCM A,[m] DAA [m]	Subtract data memory from ACC with carry Subtract data memory from ACC with carry and result in data memory Decimal adjust ACC for addition with result in data memory	1 1 <sup>(1)</sup> 1 <sup>(1)</sup>	Z,C,AC,OV Z,C,AC,OV C
Logic Operati	on		
AND A,[m] OR A,[m] XOR A,[m] ANDM A,[m] ORM A,[m] XORM A,[m] AND A,x OR A,x XOR A,x CPL [m] CPLA [m]	AND data memory to ACC OR data memory to ACC Exclusive-OR data memory to ACC AND ACC to data memory OR ACC to data memory Exclusive-OR ACC to data memory AND immediate data to ACC OR immediate data to ACC Exclusive-OR immediate data to ACC Exclusive-OR immediate data to ACC complement data memory Complement data memory	$ \begin{array}{c} 1 \\ 1 \\ 1^{(1)} \\ 1^{(1)} \\ 1^{(1)} \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1$	Z Z Z Z Z Z Z Z Z Z
Increment & I	Decrement	1	
INCA [m] INC [m] DECA [m] DEC [m]	Increment data memory with result in ACC Increment data memory Decrement data memory with result in ACC Decrement data memory	1 1 <sup>(1)</sup> 1 1 <sup>(1)</sup>	Z Z Z Z
Rotate			
RRA [m] RR [m] RRCA [m] RRC [m] RLA [m] RLCA [m] RLCA [m]	Rotate data memory right with result in ACC Rotate data memory right Rotate data memory right through carry with result in ACC Rotate data memory right through carry Rotate data memory left with result in ACC Rotate data memory left Rotate data memory left Rotate data memory left through carry with result in ACC Rotate data memory left through carry	$ \begin{array}{c} 1 \\ 1^{(1)} \\ 1 \\ 1^{(1)} \\ 1 \\ 1^{(1)} \\ 1 \\ 1^{(1)} \\ 1^{(1)} \\ \end{array} $	None C C None None C C
Data Move			
MOV A,[m] MOV [m],A MOV A,x	Move data memory to ACC Move ACC to data memory Move immediate data to ACC	1 1 <sup>(1)</sup> 1	None None None
Bit Operation	1		
CLR [m].i SET [m].i	Clear bit of data memory Set bit of data memory	1 <sup>(1)</sup> 1 <sup>(1)</sup>	None None



Mnemonic	Description	Instruction Cycle	Flag Affected
Branch			
JMP addr	Jump unconditionally	2	None
SZ [m]	Skip if data memory is zero	1 <sup>(2)</sup>	None
SZA [m]	Skip if data memory is zero with data movement to ACC	1 <sup>(2)</sup>	None
SZ [m].i	Skip if bit i of data memory is zero	1 <sup>(2)</sup>	None
SNZ [m].i	Skip if bit i of data memory is not zero	1 <sup>(2)</sup>	None
SIZ [m]	Skip if increment data memory is zero	1 <sup>(3)</sup>	None
SDZ [m]	Skip if decrement data memory is zero	1 <sup>(3)</sup>	None
SIZA [m]	Skip if increment data memory is zero with result in ACC	1 <sup>(2)</sup>	None
SDZA [m]	Skip if decrement data memory is zero with result in ACC	1 <sup>(2)</sup>	None
CALL addr	Subroutine call	2	None
RET	Return from subroutine	2	None
RET A,x	Return from subroutine and load immediate data to ACC	2	None
RETI	Return from interrupt	2	None
Table Read			
TABRDC [m]	Read ROM code (current page) to data memory and TBLH	$2^{(1)}_{2^{(1)}}$	None
TABRDL [m]	Read ROM code (last page) to data memory and TBLH	2(1)	None
Miscellaneous	S		
NOP	No operation	1	None
CLR [m]	Clear data memory	1 <sup>(1)</sup>	None
SET [m]	Set data memory	1 <sup>(1)</sup>	None
CLR WDT	Clear Watchdog Timer	1	TO,PDF
CLR WDT1	Pre-clear Watchdog Timer	1	TO <sup>(4)</sup> , PDF <sup>(4)</sup>
CLR WDT2	Pre-clear Watchdog Timer	1	TO <sup>(4)</sup> , PDF <sup>(4)</sup>
SWAP [m]	Swap nibbles of data memory	1 <sup>(1)</sup>	None
SWAPA [m]	Swap nibbles of data memory with result in ACC	1	None
HALT	Enter power down mode	1	TO,PDF

Note: x: Immediate data

- m: Data memory address
- A: Accumulator

i: 0~7 number of bits

addr: Program memory address

- ${\bf \sqrt{:}}$  Flag is affected
- -: Flag is not affected
- <sup>(1)</sup>: If a loading to the PCL register occurs, the execution cycle of instructions will be delayed for one more cycle (four system clocks).
- <sup>(2)</sup>: If a skipping to the next instruction occurs, the execution cycle of instructions will be delayed for one more cycle (four system clocks). Otherwise the original instruction cycle is unchanged.
- $^{(3)}\!\!:{}^{(1)}$  and  $^{(2)}\!\!$
- <sup>(4)</sup>: The flags may be affected by the execution status. If the Watchdog Timer is cleared by executing the "CLR WDT1" or "CLR WDT2" instruction, the TO and PDF are cleared. Otherwise the TO and PDF flags remain unchanged.



## Instruction Definition

ADC A,[m]	Add data	memory a	nd carry to		mulator		
Description			specified on specified of the result of the				the carry
Operation	$ACC \leftarrow A$	CC+[m]+C	)				
Affected flag(s)							
	то	PDF	OV	Z	AC	С	
			$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$	
DCM A,[m]	Add the a	ccumulato	r and carr	γ to data r	nemory		
Description			specified on specified of the specified				l the carry y.
peration	$[m] \gets AC$	C+[m]+C					
Affected flag(s)							
	то	PDF	OV	Z	AC	С	
			$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$	
NDD A,[m]	Add data	memory to	the accur	nulator			
escription					orv and the	e accumul	ator are ad
Comption -		he accum					
Operation	$ACC \leftarrow A$	CC+[m]					
ffected flag(s)							
	ТО	PDF	OV	Z	AC	С	
	_		$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$	
	Addimme	diata data	to the acc	umulator			
ADD A,x	Add IIIIIIe		i to the act	unnulator			
<b>Second at 1</b>	The sector						
Description	The conte accumula		accumulate	or and the	specified o	data are ao	lded, leavi
	accumula	tor.	accumulate	or and the	specified o	data are a	lded, leavi
Operation		tor.	accumulate	or and the	specified o	data are a	lded, leavi
Operation	accumula	tor.	accumulate	or and the	specified o	data are ao	lded, leavi
Operation	accumula ACC ← A	tor. CC+x					lded, leavii
Description Operation Affected flag(s)	accumula ACC ← A TO 	tor. CC+x PDF	OV V	Z√	AC √	С	lded, leaviı
Operation Affected flag(s) ADDM A,[m]	accumula ACC ← A TO  Add the a	tor. CC+x PDF  ccumulato	OV √ r to the da	Z √ ta memor	AC √ y	C √	
Operation Affected flag(s) ADDM A,[m]	accumula ACC ← A TO  Add the a	tor. CC+x PDF 	OV √ r to the da	Z √ ta memor	AC √ y	C √	lded, leavin
Operation Affected flag(s) ADDM A,[m] Description	accumula ACC ← A TO — Add the a The conte	tor. CC+x PDF 	OV √ r to the da	Z √ ta memor	AC √ y	C √	
Operation Affected flag(s) ADDM A,[m] Description Operation	accumula ACC ← A TO  Add the a The conte stored in t	tor. CC+x PDF 	OV √ r to the da	Z √ ta memor	AC √ y	C √	
Operation	accumula ACC ← A TO  Add the a The conte stored in t	tor. CC+x PDF 	OV √ r to the da	Z √ ta memor	AC √ y	C √	



AND A,[m]	-		ulator with		-			
Description			ator and the s stored in			nory perfo		
Operation	$ACC \leftarrow A$	CC "AND	' [m]					
Affected flag(s)								
	ТО	PDF	OV	Z	AC	С		
AND A,x	Logical A	ND immed	iate data to	the accu	imulator			
Description	Data in the accumulator and the specified data perform a bitwise lo The result is stored in the accumulator.							
Operation	$ACC \leftarrow A$	CC "AND	′ x					
Affected flag(s)								
	ТО	PDF	OV	Z	AC	С		
			_	$\checkmark$		—		
ANDM A,[m]	Logical A	ND data m	emory with	the accu	mulator			
Description	-		data mem			ator perfe		
Description		•	s stored in	•				
Operation	$[m] \leftarrow AC$	C "AND"	m]					
Affected flag(s)								
	ТО	PDF	OV	Z	AC	С		
			_					
CALL addr	Subroutin	e call						
Description								
	The instruction unconditionally calls a subroutine located at program counter increments once to obtain the address of the							
	program	counter inc	rements or	ice to obta	ain the add	ress of th		
	program of this onto	counter inc the stack.		ice to obta ted addre	ain the add	ress of th		
Operation	program of this onto with the ir	counter inc the stack. Instruction a	rements or The indica at this addr	ice to obta ted addre	ain the add	ress of th		
Operation	program of this onto with the ir Stack $\leftarrow$ I	counter inc the stack.	rements or The indica at this addr counter+1	ice to obta ted addre	ain the add	ress of th		
Operation Affected flag(s)	program of this onto with the ir Stack $\leftarrow$ I	counter inc the stack. Instruction a Program C	rements or The indica at this addr counter+1	ice to obta ted addre	ain the add	ress of th		
	program of this onto with the ir Stack $\leftarrow$ I	counter inc the stack. Instruction a Program C	rements or The indica at this addr counter+1	ice to obta ted addre	ain the add	ress of th		
	program o this onto with the ir Stack ← I Program	counter inc the stack. nstruction a Program C Counter ←	rements or The indica at this addr counter+1 - addr	ice to obta ted addre ess.	ain the add	ress of the		
	program o this onto with the ir Stack ← I Program	counter inc the stack. nstruction a Program C Counter ←	rements or The indica at this addr counter+1 - addr	ice to obta ted addre ess.	ain the add	ress of the		
Affected flag(s)	program o this onto with the ir Stack ← I Program TO  Clear data	counter inc the stack. Instruction a Program C Counter ← PDF PDF a memory	rements or The indica at this addr ounter+1 addr OV	ce to obta ted addre ess. Z	AC	C		
Affected flag(s)	program o this onto with the ir Stack ← I Program TO  Clear data	counter inc the stack. Instruction a Program C Counter ← PDF PDF a memory	rements or The indica at this addr counter+1 - addr	ce to obta ted addre ess. Z	AC	C		
Affected flag(s)	program o this onto with the ir Stack ← I Program TO  Clear data	eounter inc the stack. Instruction a Program C Counter ← PDF A memory ents of the	rements or The indica at this addr ounter+1 addr OV	ce to obta ted addre ess. Z	AC	C		
Affected flag(s) CLR [m] Description	program of this onto with the ir Stack ← I Program TO Clear data The conte	eounter inc the stack. Instruction a Program C Counter ← PDF A memory ents of the	rements or The indica at this addr ounter+1 addr OV	ce to obta ted addre ess. Z	AC	C		
Affected flag(s) CLR [m] Description Operation	program of this onto with the ir Stack ← I Program TO Clear data The conte	eounter inc the stack. Instruction a Program C Counter ← PDF A memory ents of the	rements or The indica at this addr ounter+1 addr OV	ce to obta ted addre ess. Z	AC	C		



CLR [m].i	Clear bit o	of data me	mory						
Description	The bit i c	f the spec	ified data r	nemory is	cleared to	o 0.			
Operation	[m].i ← 0								
Affected flag(s)									
	ТО	PDF	OV	Z	AC	С			
CLR WDT	Clear Wa	tchdog Tin	ner						
Description	The WDT cleared.								
Operation	WDT $\leftarrow$ 00H PDF and TO $\leftarrow$ 0								
Affected flag(s)									
	ТО	PDF	OV	Z	AC	С			
	0	0							
CLR WDT1	Preclear	Watchdog	Timer						
Description	of this inst	ruction wit	NDT2, clea hout the ot has been	her precle	ar instruct	ion just se			
Operation	WDT $\leftarrow$ 0 PDF and								
Affected flag(s)									
	ТО	PDF	OV	Z	AC	С			
	0*	0*							
CLR WDT2	Preclear	Natchdog	Timer						
Description	of this ins	truction wi	NDT1, clea ithout the c has been	other prec	lear instru	ction, set			
Operation	plies this instruction has been executed and the TO and PDF flags remain unchan WDT $\leftarrow$ 00H* PDF and TO $\leftarrow$ 0*								
	PDF and	TO ← 0*							
Affected flag(s)	PDF and	TO ← 0*							
Affected flag(s)	PDF and	PDF	OV	Z	AC	С			
Affected flag(s)			0V —	Z	AC	C			
Affected flag(s) CPL [m]	TO 0*	PDF		Z 	AC	C			
	TO 0* Complem Each bit o	PDF 0* ent data m			s logically				
CPL [m]	TO 0* Complem Each bit o	PDF 0* ent data m of the spectiviously co	memory cified data		s logically				
CPL [m] Description	TO 0* Complem Each bit o which pre	PDF 0* ent data m of the spectiviously co	memory cified data		s logically				
<b>CPL [m]</b> Description Operation	TO 0* Complem Each bit o which pre	PDF 0* ent data m of the spectiviously co	memory cified data		s logically				



CPLA [m] Description	Compleme Each bit o which prev	f the spec	ified data	memory i	s logically	complem	
	is stored in				-		
Operation	$ACC \leftarrow [n]$	_ 1]					
Affected flag(s)							
	ТО	PDF	OV	Z	AC	С	
	—		—	$\checkmark$			
DAA [m]	Decimal-A	djust accu	umulator fo	or addition	1		
Description	The accur lator is div carry (AC justment is carry (AC in the data	rided into t I) will be d s done by s or C) is set	wo nibbles one if the lo adding 6 to t; otherwise	s. Each ni ow nibble o the origin e the origin	bble is adj of the accu nal value if nal value re	usted to t mulator is the origin emains ur	
Operation	in the data memory and only the carry flag (C) may be affect If ACC.3~ACC.0 >9 or AC=1 then [m].3~[m].0 $\leftarrow$ (ACC.3~ACC.0)+6, AC1= $\overline{AC}$ else [m].3~[m].0 $\leftarrow$ (ACC.3~ACC.0), AC1=0 and If ACC.7~ACC.4+AC1 >9 or C=1 then [m].7~[m].4 $\leftarrow$ ACC.7~ACC.4+6+AC1,C=1						
		~[m].4 ←	ACC.7~AC	CC.4+6+A			
Affected flag(s)	then [m].7	~[m].4 ←	ACC.7~AC	CC.4+6+A			
Affected flag(s)	then [m].7	~[m].4 ←	ACC.7~AC	CC.4+6+A		С	
Affected flag(s)	then [m].7 else [m].7	~[m].4 ← . ~[m].4 ← .	ACC.7~AC ACC.7~AC	CC.4+6+A CC.4+AC1	,C=C	C √	
	then [m].7 else [m].7 TO	~[m].4 ← . ~[m].4 ← . PDF	ACC.7~AC ACC.7~AC OV	CC.4+6+A CC.4+AC1	,C=C	-	
DEC [m]	then [m].7 else [m].7 TO — Decremer	~[m].4 ← . ~[m].4 ← . PDF 	ACC.7~AC ACC.7~AC OV 	2C.4+6+A 2C.4+AC1 	,C=C AC	V	
DEC [m] Description	then [m].7 else [m].7 TO Decremen Data in the	~[m].4 ← . ~[m].4 ← . PDF 	ACC.7~AC ACC.7~AC OV 	2C.4+6+A 2C.4+AC1 	,C=C AC	V	
DEC [m] Description Operation	then [m].7 else [m].7 TO — Decremer	~[m].4 ← . ~[m].4 ← . PDF 	ACC.7~AC ACC.7~AC OV 	2C.4+6+A 2C.4+AC1 	,C=C AC	V	
DEC [m] Description	then [m].7 else [m].7 TO Decremen Data in the	~[m].4 ← . ~[m].4 ← . PDF 	ACC.7~AC ACC.7~AC OV 	2C.4+6+A 2C.4+AC1 	,C=C AC	V	
DEC [m] Description Operation	then [m].7 else [m].7 TO Decremen Data in the [m] $\leftarrow$ [m]	~[m].4 ← / ~[m].4 ← / PDF 	ACC.7~AC ACC.7~AC OV — mory d data men	CC.4+6+A CC.4+AC1 Z 	,C=C AC — cremented	√	
<b>DEC [m]</b> Description Operation Affected flag(s)	then [m].7 else [m].7 TO Decremen Data in the $[m] \leftarrow [m]$ TO 	~[m].4 ← / ~[m].4 ← / PDF 	ACC.7~AC ACC.7~AC OV — mory d data men OV —	CC.4+6+A CC.4+AC1 	,C=C AC — cremented AC —	√ by 1. 	
DEC [m] Description Operation Affected flag(s)	then [m].7 else [m].7 TO Decremen Data in the [m] $\leftarrow$ [m] TO Decremen	~[m].4 ← . ~[m].4 ← . PDF 	ACC.7~AC ACC.7~AC OV — mory d data men OV — OV —	CC.4+6+A CC.4+AC1 Z — nory is de Z √ place resu	,C=C AC — cremented AC — ult in the ad	√ I by 1. C 	
<b>DEC [m]</b> Description Operation Affected flag(s)	then [m].7 else [m].7 TO Decremen Data in the $[m] \leftarrow [m]$ TO 	~[m].4 ← / ~[m].4 ← / PDF 	ACC.7~AC ACC.7~AC OV — mory data men OV — Mory and j data mem	CC.4+6+A CC.4+AC1 Z 	,C=C AC cremented AC ult in the ad remented	√ by 1. C — ccumulato by 1, leavi	
DEC [m] Description Operation Affected flag(s)	then [m].7 else [m].7 TO Decremen Data in the $[m] \leftarrow [m]$ TO Decremen Data in the	~[m].4 ← / ~[m].4 ← / PDF — at data me e specified PDF — 1 PDF — at data me e specified ontents of	ACC.7~AC ACC.7~AC OV — mory data men OV — Mory and j data mem	CC.4+6+A CC.4+AC1 Z 	,C=C AC cremented AC ult in the ad remented	√ by 1. C — ccumulato by 1, leavi	
DEC [m] Description Operation Affected flag(s) DECA [m] Description	then [m].7 else [m].7 TO Decremen Data in the [m] $\leftarrow$ [m] TO Decremen Data in the tor. The co	~[m].4 ← / ~[m].4 ← / PDF — at data me e specified PDF — 1 PDF — at data me e specified ontents of	ACC.7~AC ACC.7~AC OV — mory data men OV — Mory and j data mem	CC.4+6+A CC.4+AC1 Z 	,C=C AC cremented AC ult in the ad remented	√ by 1. C ccumulato by 1, leavi anged.	
DEC [m] Description Operation Affected flag(s) DECA [m] Description Operation	then [m].7 else [m].7 TO Decremen Data in the [m] $\leftarrow$ [m] TO Decremen Data in the tor. The co	~[m].4 ← / ~[m].4 ← / PDF — at data me e specified PDF — 1 PDF — at data me e specified ontents of	ACC.7~AC ACC.7~AC OV — mory data men OV — Mory and j data mem	CC.4+6+A CC.4+AC1 Z 	,C=C AC cremented AC ult in the ad remented	√ by 1. C — ccumulato by 1, leavi	



HALT	Enter pow					
Description	the RAM a	and registe	ers are reta	n execution ained. The time-out bi	WDT and	prescaler
Operation	Program ( PDF $\leftarrow$ 1 TO $\leftarrow$ 0	Counter ←	- Program	Counter+	1	
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
	0	1				
INC [m]	Increment	t data mer	nory			
Description	Data in th	e specifie	d data mei	mory is inc	remented	by 1
Operation	[m] ← [m]	+1				
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
				$\checkmark$		
INCA [m]	Increment	t data mer	nory and p	blace resul	t in the ac	cumulator
Description				nory is incr		
	tor. The co	ontents of	the data r	nemory re	main unch	anged.
Operation	$ACC \gets [n]$	n]+1				
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
	_	—		$\checkmark$		
JMP addr	Directly ju	mp				
Description	The progr control is			aced with th nation.	he directly	-specified
Operation	Program (	Counter ←	-addr			
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
		—	_	_		
MOV A,[m]	Move data	a memory	to the acc	umulator		
Description				data mem	ory are co	pied to the
Operation	$ACC \leftarrow [n]$		•		-	
Affected flag(s)	· [·	-				
	ТО	PDF	OV	Z	AC	С
	_		_			_



MOV A,x	Move imn	nediate da	ta to the ad	ccumulato	r	
Description	The 8-bit	data speci	fied by the	code is lo	aded into	the accu
Operation	$ACC \leftarrow x$					
Affected flag(s)	[					
	ТО	PDF	OV	Z	AC	С
		—	_	—	—	
MOV [m],A	Move the	accumula	tor to data	memory		
Description	The conte memories		accumulate	or are cop	ed to the	specified
Operation	[m] ←AC0	C				
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
		—	—			
NOP	No operat	ion				
Description	No operat	ion is perf	ormed. Ex	ecution co	ntinues w	ith the ne
Operation	Program	Counter ←	- Program	Counter+	l	
Affected flag(s)						
	то	PDF	OV	Z	AC	С
		—			_	
OR A,[m]	Logical O	R accumu	lator with c	lata memo	ory	
Description	•		lator and th		-	emory (o
			al_OR ope			
Operation	$ACC \leftarrow A$	CC "OR"	[m]			
Affected flag(s)	[					
	ТО	PDF	OV	Z	AC	С
		_	—		_	
OR A,x	Logical O	R immedia	ate data to	the accun	nulator	
Description	Data in th	e accumu	lator and t			
•					ed data p	erform a
			in the accu		ed data p	erform a
Operation		is stored	in the accu		ed data p	erform a
	The result	is stored	in the accu	imulator.	ed data p	erform a
Operation	The result	is stored	in the accu		AC	erform a
Operation	The result ACC ← A	t is stored	in the accu x	imulator.		
Operation	The result ACC ← A TO 	t is stored CC "OR" PDF	in the accu x	zmulator. Z √	AC	
Operation Affected flag(s)	The result ACC ← A TO Logical O	t is stored CC "OR" PDF R data me	in the accu x OV	imulator. Z √ the accun	AC — nulator	C —
Operation Affected flag(s) ORM A,[m]	The result ACC ← A TO Logical O Data in th	CC "OR" PDF R data me ne data m	OV	z Z √ the accun e of the c	AC — nulator lata mem	C — ories) an
Operation Affected flag(s) ORM A,[m]	The result ACC ← A TO Logical O Data in th	PDF R data me ne data m gical_OR d	OV OV emory with emory (on operation.	z Z √ the accun e of the c	AC — nulator lata mem	C — ories) an
Operation Affected flag(s) ORM A,[m] Description	The result ACC ← A TO Logical O Data in th bitwise log	PDF R data me ne data m gical_OR d	OV OV emory with emory (on operation.	z Z √ the accun e of the c	AC — nulator lata mem	C — ories) an
Operation Affected flag(s) ORM A,[m] Description Operation	The result ACC ← A TO Logical O Data in th bitwise log	PDF R data me ne data m gical_OR d	OV OV emory with emory (on operation.	z Z √ the accun e of the c	AC — nulator lata mem	C — ories) an



RET	Return fro	om subrou	tine			
Description	The program counter is restored from the stack. This is a 2-cycle instruction.					
Operation	Program	Counter ←	<ul> <li>Stack</li> </ul>			
Affected flag(s)	[					
	ТО	PDF	OV	Z	AC	С
		_				
RET A,x	Return ar	nd place in	nmediate c	lata in the	accumula	tor
Description	The program counter is restored from the stack and the accumulator loaded with the fied 8-bit immediate data.					
Operation	$\begin{array}{l} Program \\ ACC \leftarrow x \end{array}$	Counter ←	- Stack			
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
		—		_	_	—
RETI	Return fro	om interrup	ot			
Description			er is restor enable ma			
Operation	Program EMI ← 1	Counter ←	- Stack			
Affected flag(s)	[					
	ТО	PDF	OV	Z	AC	С
		_	—			—
RL [m]	Rotate da	ita memor	y left			
Description	The conte	ents of the	specified d	ata memo	ry are rota	ted 1 bit le
Operation	[m].(i+1) √ [m].0 ← [i		ı].i:bit i of t	he data m	emory (i=0	0~6)
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
RLA [m]	Rotate da	ita memor	y left and p	place resul	It in the ac	cumulator
Description		•	l data men accumula			
Operation	ACC.(i+1 ACC.0 ←		m].i:bit i of	the data r	memory (i	=0~6)
Affected flag(s)	[					
	ТО	PDF	OV	Z	AC	С
		—		—		



RLC [m]	Rotate da	ta memor	y left throu	ah carry		
Description	The conte	ents of the	specified c the origina	ata memo		
Operation	[m].(i+1) ↔ [m].0 ← C C ← [m].7	;	].i:bit i of tl	ne data m	emory (i=(	)~6)
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
			_			$\checkmark$
RLCA [m]	Rotate lef	t through	carry and p	lace resu	It in the ac	cumulato
Description	carry bit a	nd the orig	l data merr ginal carry out the cor	flag is rota	ited into bi	t 0 positio
Operation	ACC.(i+1) ACC.0 ← C ← [m].7	С	m].i:bit i of	the data r	memory (i	=0~6)
Affected flag(s)			01/	-		-
	ТО	PDF	OV	Z	AC	C
						$\checkmark$
RR [m]	Rotate da	ta memor	y right			
Description	The conte	nts of the	specified d	ata memo	ry are rota	ted 1 bit rio
Operation		, -	].i:bit i of tl	ne data m	emory (i=0	0~6)
	[m].7 ← [I	11].0				
Affected flag(s)						
Affected flag(s)	ТО	PDF	OV	Z	AC	С
Affected flag(s)	T0	PDF	OV	Z	AC	C
						C
Affected flag(s) <b>RRA [m]</b> Description	Rotate rig	ht and pla	OV — ce result ir d data mer he accumu	the accu	mulator ated 1 bit	right with t
RRA [m]	Rotate rig Data in th the rotate	ht and pla e specified d result in f	 ce result ir d data mer	the accu nory is rota ulator. The	mulator ated 1 bit contents	right with t
RRA [m] Description	Rotate rig Data in th the rotate ACC.(i) ← ACC.7 ←	ht and pla e specified d result in f - [m].(i+1); [m].0	ce result ir d data mer the accumu [m].i:bit i d	n the accu nory is rota ulator. The of the data	mulator ated 1 bit contents memory	right with to f the data (i=0~6)
<b>RRA [m]</b> Description Operation	Rotate rig Data in th the rotate ACC.(i) ←	ht and pla e specified d result in f	ce result in d data mer the accum	the accu nory is rota ulator. The	mulator ated 1 bit contents	right with t
<b>RRA [m]</b> Description Operation	Rotate rig Data in th the rotate ACC.(i) ← ACC.7 ←	ht and pla e specified d result in f - [m].(i+1); [m].0	ce result ir d data mer the accumu [m].i:bit i d	n the accu nory is rota ulator. The of the data	mulator ated 1 bit contents memory	right with to f the data (i=0~6)
<b>RRA [m]</b> Description Operation	Content and the rotate rig Data in the the rotate ACC.(i) ← ACC.7 ←	ht and pla e specified d result in f - [m].(i+1); [m].0 PDF	ce result ir d data mer the accumu [m].i:bit i d	n the accu nory is rota ulator. The of the data Z	mulator ated 1 bit contents memory	right with to f the data (i=0~6)
<b>RRA [m]</b> Description Operation Affected flag(s)	Rotate rig Data in th the rotate ACC.(i) ← ACC.7 ← TO  Rotate da The conte	ht and pla e specified d result in f - [m].(i+1); [m].0 PDF 	ce result ir d data mer the accumu [m].i:bit i o OV	n the accu nory is rota ulator. The of the data Z  ugh carry data mem	mulator ated 1 bit i contents of memory AC 	right with to find the data (i=0~6)
RRA [m] Description Operation Affected flag(s)	—         Rotate rig         Data in th         the rotate         ACC.(i) ←         ACC.7 ←         TO	ht and pla e specified d result in f - [m].(i+1); [m].0 PDF 	ce result ir d data mer he accumu [m].i:bit i d OV  y right thro specified	 n the accu nory is rota ulator. The of the data Z  ugh carry data mem oit; the orig	mulator ated 1 bit contents memory AC — nory and t ginal carry	right with t of the data (i=0~6) C — he carry fl flag is rot
RRA [m] Description Operation Affected flag(s) RRC [m] Description	Rotate rig Data in th the rotate ACC.(i) $\leftarrow$ ACC.7 $\leftarrow$ TO — Rotate da The conte right. Bit ( [m].i $\leftarrow$ [n [m].7 $\leftarrow$ C C $\leftarrow$ [m].0	ht and pla e specified d result in f - [m].(i+1); [m].0 PDF 	ce result in d data mer the accumu [m].i:bit i of OV 	 n the accu nory is rota ulator. The of the data Z  ugh carry data mem pit; the orig ne data me	mulator ated 1 bit contents memory AC 	right with t of the data (i=0~6) C C he carry fl flag is rot D~6)
RRA [m] Description Operation Affected flag(s) RRC [m] Description Operation	Rotate rig Data in th the rotate ACC.(i) $\leftarrow$ ACC.7 $\leftarrow$ TO  Rotate da The conte right. Bit ( [m].i $\leftarrow$ [n [m].7 $\leftarrow$ O	ht and pla e specified d result in f - [m].(i+1); [m].0 PDF 	ce result in d data mer the accumu [m].i:bit i d OV  y right thro specified the carry b	 n the accu nory is rota ulator. The of the data Z  ugh carry data mem oit; the orig	mulator ated 1 bit contents memory AC — nory and t ginal carry	right with t of the data (i=0~6) C — he carry fl flag is rot



RRCA [m]	Rotate rig	ht through	carry and	place res	ult in the a	ccumulato	or
Description	Data of the specified data memory and the carry flag are rotated 1 bit right. Bit 0 replace the carry bit and the original carry flag is rotated into the bit 7 position. The rotated result stored in the accumulator. The contents of the data memory remain unchanged.						
Operation	ACC.i $\leftarrow$ [m].(i+1); [m].i:bit i of the data memory (i=0~6) ACC.7 $\leftarrow$ C C $\leftarrow$ [m].0						
Affected flag(s)							
	ТО	PDF	OV	Z	AC	С	
		—			_	$\checkmark$	
SBC A,[m]	Subtract of	lata memo	ory and ca	rry from th	ie accumu	ator	
Description			•		ory and the e result in	•	ent of the carry flag are su ulator.
Operation	$ACC \leftarrow A$	CC+[m]+0					
Affected flag(s)							
	ТО	PDF	OV	Z	AC	С	
			$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$	
SBCM A,[m]	Subtract of	lata memo	ory and ca	rry from th	e accumu	ator	
Description			-				ent of the carry flag are su
	tracted fro	om the acc	umulator,	leaving th	e result in	the data m	nemory.
Operation	$[m] \gets AC$	C+[m]+C					
Affected flag(s)							
	ТО	PDF	OV	Z	AC	С	
		—	V	$\checkmark$	$\checkmark$	$\checkmark$	
		rement d	ata memoi	ry is 0			
SDZ [m]	Skip if deo	of official as					by 1. If the result is 0, the ne
	The conte instructior instructior	nts of the s i is skippe i execution	d. If the rea	sult is 0, th ded and a	ne following	g instructio cle is repla	n, fetched during the curre ced to get the proper instru
Description	The content instruction instruction tion (2 cyc	nts of the s is skippe execution cles). Othe	d. If the rea	sult is 0, th ded and a ceed with	ne following dummy cy	g instructio cle is repla	n, fetched during the curre ced to get the proper instru
Description Operation	The content instruction instruction tion (2 cyc	nts of the s is skippe execution cles). Othe	d. If the rea n, is discar erwise proc	sult is 0, th ded and a ceed with	ne following dummy cy	g instructio cle is repla	n, fetched during the curre ced to get the proper instru
Description	The content instruction instruction tion (2 cyc	nts of the s is skippe execution cles). Othe	d. If the rea n, is discar erwise proc	sult is 0, th ded and a ceed with	ne following dummy cy	g instructio cle is repla	n, fetched during the curre ced to get the proper instru
Description Operation	The conte instructior instructior tion (2 cyc Skip if ([m	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n	d. If the react n, is discard erwise proc n] $\leftarrow$ ([m]–	sult is 0, th ded and a ceed with 1)	ne following dummy cy the next in	g instruction cle is repla struction (	n, fetched during the curre ced to get the proper instru
Description Operation Affected flag(s)	The conte instructior instruction tion (2 cyc Skip if ([m TO	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n PDF	d. If the read n, is discard erwise prod n] ← ([m]– OV	sult is 0, the ded and a coord with 1)	AC	g instructio cle is repla struction ( C	n, fetched during the curre ced to get the proper instru
SDZ [m] Description Operation Affected flag(s) SDZA [m] Description	The conte instruction instruction tion (2 cyc Skip if ([m TO Decremen The conte instruction unchange execution	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n PDF 	d. If the reaction of the second sec	sult is 0, th ded and a ceed with 1) Z place resu ata memo ult is stored e following dummy cy	AC AC AC AC AC AC AC AC AC AC AC AC AC A	cle is repla struction ( C 	n, fetched during the curre ced to get the proper instru
Description Operation Affected flag(s) SDZA [m] Description	The conte instructior instruction (2 cyc Skip if ([m TO Decremen The conte instructior unchange execution cles). Oth	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n PDF 	d. If the reaction of the second sec	sult is 0, th ded and a ceed with 1) Z place resu ata memo ult is stored e following dummy cy the next i	AC AC AC AC AC AC AC AC AC AC AC AC AC A	cle is repla struction ( C 	n, fetched during the curre ced to get the proper instru- 1 cycle). by 1. If the result is 0, the ne but the data memory remai during the current instructi
Description Operation Affected flag(s) SDZA [m] Description Operation	The conte instructior instruction (2 cyc Skip if ([m TO Decremen The conte instructior unchange execution cles). Oth	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n PDF 	d. If the rest h, is discar- erwise proce- OV	sult is 0, th ded and a ceed with 1) Z place resu ata memo ult is stored e following dummy cy the next i	AC AC AC AC AC AC AC AC AC AC AC AC AC A	cle is repla struction ( C 	n, fetched during the curre ced to get the proper instru- 1 cycle). by 1. If the result is 0, the ne but the data memory remai during the current instructi
Description Operation Affected flag(s)	The conte instructior instruction (2 cyc Skip if ([m TO Decremen The conte instructior unchange execution cles). Oth	nts of the s n is skippe n execution cles). Othe ]–1)=0, [n PDF — nt data me nts of the s n is skippe d. If the re n is discard erwise pro	d. If the rest h, is discar- erwise proce- OV	sult is 0, th ded and a ceed with 1) Z place resu ata memo ult is stored e following dummy cy the next i	AC AC AC AC AC AC AC AC AC AC AC AC AC A	cle is repla struction ( C 	n, fetched during the curre ced to get the proper instru- 1 cycle). by 1. If the result is 0, the ne but the data memory remainduring the current instruction



SET [m]	Set data memory					
Description	Each bit of the sp	ecified data i	memory is	set to 1.		
Operation	[m] ← FFH					
Affected flag(s)						
	TO PDF	OV	Z	AC	С	
				_	—	
SET [m]. i	Set bit of data me	morv				
Description	Bit i of the specifi	•	ory is set	to 1.		
Operation	[m].i ← 1					
Affected flag(s)						
0()	TO PDF	OV	Z	AC	С	
			_	_		
SIZ [m]	Skip if increment	data memori	vie 0			
Description				ny are incr	omented k	by 1. If the result is 0, the fol-
Description		•		•		ecution, is discarded and a
			et the prop	er instructi	on (2 cycl	es). Otherwise proceed with
	the next instruction	,				
Operation	Skip if ([m]+1)=0,	[m] ← ([m]+	1)			
Affected flag(s)		<b>e</b> ) (	_		-	
	TO PDF	OV	Z	AC	С	
SIZA [m]	Increment data m	emory and p	lace resul	t in ACC, s	kip if 0	
Description	The contents of th	e specified d	ata memo	ry are incre	emented b	by 1. If the result is 0, the next
		•				ulator. The data memory re-
	-			-		fetched during the current in- replaced to get the proper
	instruction (2 cycl					
Operation	Skip if ([m]+1)=0,	ACC $\leftarrow$ ([m]	+1)			
Affected flag(s)						1
	TO PDF	OV	Z	AC	С	
			—			
SNZ [m].i	Skip if bit i of the	data memory	/ is not 0			
Description	If bit i of the specif	ied data men	nory is not	0, the next	instructior	n is skipped. If bit i of the data
		-			-	current instruction execution,
	is discarded and a wise proceed with				he proper	instruction (2 cycles). Other-
Operation	Skip if [m].i≠0			<i>syoidj</i> .		
Affected flag(s)	OKIÞ II [III].I≁O					
	TO PDF	OV	Z	AC	С	
			_	_		



SUB A,[m]			ory from th					
Description	•	ified data r he accum		subtracted	from the c	contents of	the accumul	ator, lea
Operation	$ACC \leftarrow A$	CC+[m]+	1					
Affected flag(s)							1	
	ТО	PDF	OV	Z	AC	С		
	_	_	$\checkmark$		$\checkmark$	$\checkmark$		
SUBM A,[m]	Subtract	data mem	ory from th	e accumu	lator			
Description		ified data r he data m		subtracted	from the c	contents of	the accumul	ator, lea
Operation	$[m] \leftarrow AC$	C+[m]+1						
ffected flag(s)								
	ТО	PDF	OV	Z	AC	С		
	_		$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$		
SUB A,x	Subtract i	mmediate	data from	the accur	nulator			
Description						cted from t	he contents c	f the a
			It in the ac	•				
peration	$ACC \leftarrow A$	CC+x+1						
	$ACC \leftarrow A$	CC+x+1						
	ACC ← A	CC+x+1	OV	Z	AC	С		
			OV √	Z √	AC √	C √		
Affected flag(s)	TO —	PDF	√	V	-	-		
Affected flag(s)	TO — Swap nib The low-o	PDF — bles withir	√ n the data r high-order	√ memory	N	V	emory (1 of	he dat
w <b>GFE</b> (m)	TO — Swap nib The low-o ries) are i	PDF — bles withir order and nterchang	√ n the data r high-order red.	√ memory	N	V	emory (1 of	he dat
Iffected flag(s) WAP [m] Description Operation	TO — Swap nib The low-o ries) are i	PDF — bles withir	√ n the data r high-order red.	√ memory	N	V	nemory (1 of t	he dat
Affected flag(s) SWAP [m] Description Operation	TO — Swap nib The low-o ries) are i	PDF — bles withir order and nterchang	√ n the data r high-order red.	√ memory	N	V	nemory (1 of t	he dat
Affected flag(s) SWAP [m] Description Operation	TO — Swap nib The low-c ries) are i [m].3~[m]	PDF — bles withir order and l nterchang .0 ↔ [m].7	√ h the data r high-order red. 7~[m].4	√ memory nibbles of	√ The specif	√ ied data m	emory (1 of t	he dat
Operation Affected flag(s) SWAP [m] Description Operation Affected flag(s)	TO — Swap nib The low-c ries) are i [m].3~[m] TO —	PDF 	√ h the data r high-order red. 7~[m].4 OV 	√ memory nibbles of Z	√ The specif	√ ied data m C	nemory (1 of t	he dat
SWAP [m] Description Operation Affected flag(s)	TO — Swap nib The low-o ries) are i [m].3~[m] TO — Swap dat	PDF bles withir order and nterchang .0 ↔ [m]. PDF  a memory	√ h the data r high-order red. 7~[m].4 OV  r and place	√ memory nibbles of Z 	√       the specif       AC          the accumute	√ ied data m C  ulator		
Affected flag(s) SWAP [m] Description Operation	TO — Swap nib The low-o ries) are i [m].3~[m] TO — Swap dat The low-o	PDF 	√ h the data r high-order red. 7~[m].4 OV OV and place high-order r	v memory nibbles of Z 	√       the specification       AC	√ ied data m C  ulator ed data me	emory (1 of t emory are inte	erchan
Affected flag(s) SWAP [m] Description Operation Affected flag(s) SWAPA [m] Description	TO — Swap nib The low-o ries) are i [m].3~[m] TO — Swap dat The low-o ing the re ACC.3~A	PDF bles within order and l nterchang $.0 \leftrightarrow [m]$ . PDF a memory order and h sult to the CC.0 $\leftarrow$ [r	√ n the data r high-order red. 7~[m].4 OV ov and place nigh-order r accumulat m].7~[m].4	v memory nibbles of Z 	√       the specification       AC	√ ied data m C  ulator ed data me	emory are inte	erchan
Affected flag(s)  SWAP [m] Description  Operation  Affected flag(s)  SWAPA [m] Description  Operation	TO — Swap nib The low-o ries) are i [m].3~[m] TO — Swap dat The low-o ing the re ACC.3~A	PDF bles within order and l nterchang $.0 \leftrightarrow [m]$ . PDF a memory order and h sult to the CC.0 $\leftarrow$ [r	√ h the data r high-order red. 7~[m].4 OV ov and place high-order r accumulat	v memory nibbles of Z 	√       the specification       AC	√ ied data m C  ulator ed data me	emory are inte	erchan
Affected flag(s) SWAP [m] Description Operation Affected flag(s) SWAPA [m]	TO — Swap nib The low-o ries) are i [m].3~[m] TO — Swap dat The low-o ing the re ACC.3~A	PDF bles within order and l nterchang $.0 \leftrightarrow [m]$ . PDF a memory order and h sult to the CC.0 $\leftarrow$ [r	√ n the data r high-order red. 7~[m].4 OV ov and place nigh-order r accumulat m].7~[m].4	v memory nibbles of Z 	√       the specification       AC	√ ied data m C  ulator ed data me	emory are inte	erchan



SZ [m]	Skip if dat	a memory						
Description	the currer	nt instructi	on executi	on, is disc	arded and	l a dummy	g instruction, feto cycle is replaced t instruction (1 cy	d to get t
Operation	Skip if [m]	=0						
Affected flag(s)								
	ТО	PDF	OV	Z	AC	С		
						—		
SZA [m]	Move data	a memory	to ACC, s	kip if 0				
Description	0, the follo and a dun	owing inst nmy cycle	ruction, fe	tched durii d to get the	ng the cur	rent instrue	ccumulator. If the tion execution, is cycles). Otherwi	s discard
Operation	Skip if [m]	=0						
Affected flag(s)								
	ТО	PDF	OV	Z	AC	С		
	—	_				—		
<b>67</b> [m] ;	Skip if bit	i of the da	ita memor	vis 0				
SZ [m].i							. fatala al dumina	41
Description	If bit i of th instructior tion (2 cyc	e specifie n execution cles). Othe	d data mer n, is discar	nory is 0, tl ded and a	dummy cy	-	n, fetched during ced to get the pro I cycle).	
Description Operation	If bit i of th instructior	e specifie n execution cles). Othe	d data mer n, is discar	nory is 0, tl ded and a	dummy cy	cle is repla	ced to get the pro	
Description	If bit i of th instructior tion (2 cyc Skip if [m]	e specifie n execution cles). Othe l.i=0	d data mer n, is discar erwise proc	nory is 0, tl ded and a ceed with t	dummy cy the next in	cle is repla struction (	ced to get the pro	
Description Operation	If bit i of th instructior tion (2 cyc	e specifie n execution cles). Othe	d data mer n, is discar	nory is 0, tl ded and a	dummy cy	cle is repla	ced to get the pro	
Description Operation Affected flag(s)	If bit i of th instructior tion (2 cyc Skip if [m] TO	e specifie n execution cles). Othe .i=0 PDF	d data mer n, is discar erwise prod OV	nory is 0, tl ded and a ceed with t Z	dummy cy the next in AC	Cle is repla struction ( C	ced to get the pro	
Description Operation Affected flag(s)	If bit i of th instruction tion (2 cyo Skip if [m] TO  Move the	e specifie n execution cles). Othe l.i=0 PDF 	d data mer n, is discar erwise prod OV  e (current	nory is 0, tl ded and a ceed with t Z  page) to T	dummy cy the next in AC BLH and o	cle is repla struction ( C 	ced to get the pro	per instru
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Description Operation Affected flag(s) <b>TABRDC [m]</b> Description Operation	If bit i of th instruction tion (2 cyc Skip if [m] TO — Move the The low b to the spec [m] $\leftarrow$ RC	e specifier n execution cles). Othe .i=0 PDF ROM cod yte of ROI wified data	d data mer n, is discar erwise prod OV e (current d code (cu a memory ow byte)	nory is 0, tl ded and a ceed with t Z page) to T rrent page and the hig	dummy cy the next in AC BLH and o	Cle is repla struction ( C 	ced to get the pro	per instru
Description Operation Affected flag(s) <b>TABRDC [m]</b> Description Operation	If bit i of th instruction tion (2 cyc Skip if [m] TO — Move the The low b to the spe [m] $\leftarrow$ RC TBLH $\leftarrow$ I	e specifie n execution cles). Othe .i=0 PDF ROM cod yte of ROI yte of ROI vcified data	d data mer n, is discar erwise prod OV e (current M code (cu a memory ow byte) e (high byte	nory is 0, tl ded and a ceed with t Z page) to T rrent page and the his	dummy cy the next in AC BLH and ( addresse gh byte tra	Cle is repla struction ( C data memo ed by the ta ansferred to	ced to get the pro	per instru
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Description Operation Affected flag(s) <b>TABRDC [m]</b> Description Operation Affected flag(s)	If bit i of th instruction tion (2 cyc Skip if [m] TO — Move the The low b to the spe [m] $\leftarrow$ RC TBLH $\leftarrow$ I TO — Move the The low b	e specifier n execution cles). Othe .i=0 PDF ROM cod yte of ROI ccified data PM code (I ROM code PDF 	d data mer n, is discar erwise prod OV e (current M code (cu a memory ow byte) e (high byte OV e (last pag M code (la	nory is 0, ti ded and a ceed with t Z page) to T rrent page and the his e) Z L e) to TBLI st page) a	AC A	Cle is repla struction ( C C data memo ed by the ta ansferred to C C C a memory	e pointer (TBLP)	P) is mov
Description Operation Affected flag(s) TABRDC [m] Description Operation Affected flag(s) TABRDL [m]	If bit i of th instruction tion (2 cyc Skip if [m] TO — Move the The low b to the spee [m] $\leftarrow$ RC TBLH $\leftarrow$ I TO — Move the The low b the data m [m] $\leftarrow$ RC	e specifier n execution cles). Othe .i=0 PDF ROM cod yte of ROI with code (I ROM code PDF ROM code yte of ROI with code (I ROM code yte of ROI nemory ar	d data mer n, is discar erwise prov OV e (current M code (cu a memory ow byte) e (high byte) e (high byte) e (last pag M code (la nd the high	nory is 0, ti ded and a ceed with t Z page) to T rrent page and the hig e) Z z e) z e) to TBLI st page) a byte trans	AC A	Cle is repla struction ( C C data memo ed by the ta ansferred to C C C a memory by the table	e pointer (TBLP)	P) is mov
Description Operation Affected flag(s) TABRDC [m] Description Operation Affected flag(s) TABRDL [m] Description	If bit i of th instruction tion (2 cyc Skip if [m] TO — Move the The low b to the spee [m] $\leftarrow$ RC TBLH $\leftarrow$ I TO — Move the The low b the data m [m] $\leftarrow$ RC	e specifier n execution cles). Othe .i=0 PDF ROM cod yte of ROI with code (I ROM code PDF ROM code yte of ROI with code (I ROM code yte of ROI nemory ar	d data mer n, is discar erwise prov OV e (current M code (cu a memory ow byte) e (high byte) e (high byte) e (last page M code (la nd the high ow byte)	nory is 0, ti ded and a ceed with t Z page) to T rrent page and the hig e) Z z e) z e) to TBLI st page) a byte trans	AC A	Cle is repla struction ( C C data memo ed by the ta ansferred to C C C a memory by the table	e pointer (TBLP)	P) is mov
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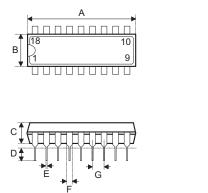
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XOR A,[m]	Logical XC		ulator with	n data mor	non	
	0					
Description	Data in the sive_OR c					5 1
Operation	$ACC \leftarrow A$	CC "XOR	" [m]			
Affected flag(s)						
	то	PDF	OV	Z	AC	С
	_			~		
			1	1	1	1
XORM A,[m]	Logical XC	OR data m	nemory wit	th the accu	umulator	
Description	Data in the sive_OR c					•
Operation	$[m] \leftarrow AC$	C "XOR"	[m]			
Affected flag(s)						
	ТО	PDF	OV	Z	AC	С
	—		_	$\checkmark$		
XOR A,x	Logical XC	DR immed	liate data t	to the accu	umulator	
Description	Data in the eration. The			·	•	
Operation	$ACC \leftarrow A$	CC "XOR	″ x			
Affected flag(s)						
	то	PDF	OV	Z	AC	С
	_	_		$\checkmark$		
			-	1		



# Package Information

18-pin DIP (300mil) Outline Dimensions

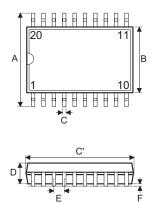


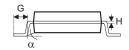


Symbol		Dimensions in mil	
Symbol	Min.	Nom.	Max.
A	895	—	915
В	240		260
С	125		135
D	125		145
E	16		20
F	50		70
G	_	100	_
Н	295		315
I	335		375
α	0°		15°



## 20-pin SOP (300mil) Outline Dimensions

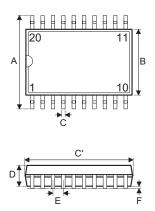




Symbol		Dimensions in mil	
Symbol	Min.	Nom.	Max.
А	394	_	419
В	290	_	300
С	14		20
C′	490		510
D	92		104
E	_	50	
F	4		
G	32	_	38
Н	4		12
α	0°		10°



# 20-pin SSOP (150mil) Outline Dimensions



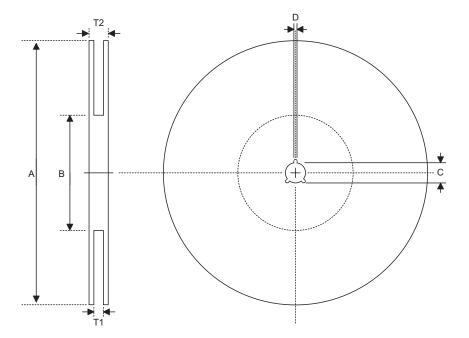


Symbol		Dimensions in mil	
Symbol	Min.	Nom.	Max.
А	228	_	244
В	150	_	158
С	8		12
C′	335		347
D	49		65
E	_	25	_
F	4		10
G	15	_	50
Н	7	_	10
α	0°		8°



# **Product Tape and Reel Specifications**

# **Reel Dimensions**



### SOP 20W

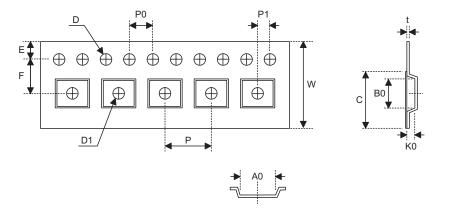
Symbol	Description	Dimensions in mm
А	Reel Outer Diameter	330±1
В	Reel Inner Diameter	62±1.5
С	Spindle Hole Diameter	13+0.5 0.2
D	Key Slit Width	2±0.5
T1	Space Between Flange	24.8+0.3 0.2
T2	Reel Thickness	30.2±0.2

# SSOP 20S (150mil)

Symbol	Description	Dimensions in mm
А	Reel Outer Diameter	330±1
В	Reel Inner Diameter	62±1.5
с	Spindle Hole Diameter	13+0.5 _0.2
D	Key Slit Width	2±0.5
T1	Space Between Flange	16.8+0.3 0.2
T2	Reel Thickness	22.2±0.2



### **Carrier Tape Dimensions**



Symbol	Description	Dimensions in mm
W	Carrier Tape Width	24+0.3 0.1
Р	Cavity Pitch	12±0.1
E	Perforation Position	1.75±0.1
F	Cavity to Perforation (Width Direction)	11.5±0.1
D	Perforation Diameter	1.5+0.1
D1	Cavity Hole Diameter	1.5+0.25
P0	Perforation Pitch	4±0.1
P1	Cavity to Perforation (Length Direction)	2±0.1
A0	Cavity Length	10.8±0.1
B0	Cavity Width	13.3±0.1
K0	Cavity Depth	3.2±0.1
t	Carrier Tape Thickness	0.3±0.05
С	Cover Tape Width	21.3

# SSOP 20S (150mil)

Symbol	Description	Dimensions in mm
W	Carrier Tape Width	16+0.3 _0.1
Р	Cavity Pitch	8±0.1
E	Perforation Position	1.75±0.1
F	Cavity to Perforation (Width Direction)	7.5±0.1
D	Perforation Diameter	1.5+0.1
D1	Cavity Hole Diameter	1.5+0.25
P0	Perforation Pitch	4±0.1
P1	Cavity to Perforation (Length Direction)	2±0.1
A0	Cavity Length	6.5±0.1
B0	Cavity Width	9±0.1
K0	Cavity Depth	2.3±0.1
t	Carrier Tape Thickness	0.3±0.05
С	Cover Tape Width	13.3

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